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Harding

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(54) **SYSTEMS AND METHODS FOR GENERATING AN IMPROVED DIFFRACTION PROFILE**

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(57) **ABSTRACT**

(52) **U.S. Cl.** **378/86; 378/71**

(58) **Field of Classification Search** 378/57, 378/86, 88, 90, 70, 71, 82, 83
See application file for complete search history.

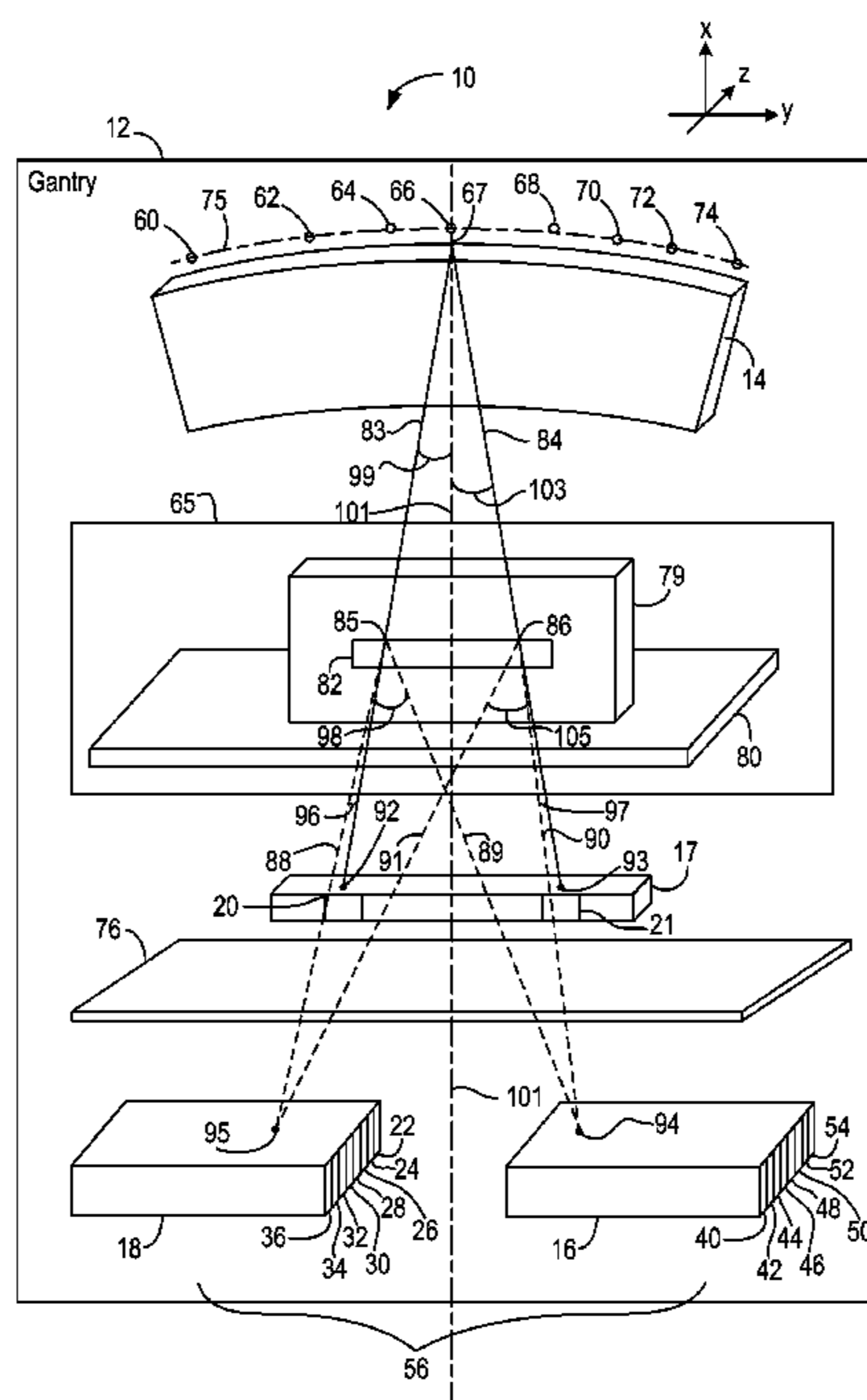
A system for generating an improved diffraction profile is described. The system includes at least one x-ray source configured to generate x-rays and a primary collimator outputting a first x-ray beam to a first focus point and a second x-ray beam to a second focus point. The primary collimator generates the first and second x-ray beams from the x-rays. The system further includes a container, and a first scatter detector configured to detect a first set of scattered radiation generated upon intersection of the first x-ray beam with the container and to detect a second set of scattered radiation generated upon intersection of the second x-ray beam with the container. An angle of scatter of the first set of scattered radiation detected by the first scatter detector is at most half of an angle of scatter of the second set of scattered radiation detected by the first scatter detector.

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20 Claims, 12 Drawing Sheets



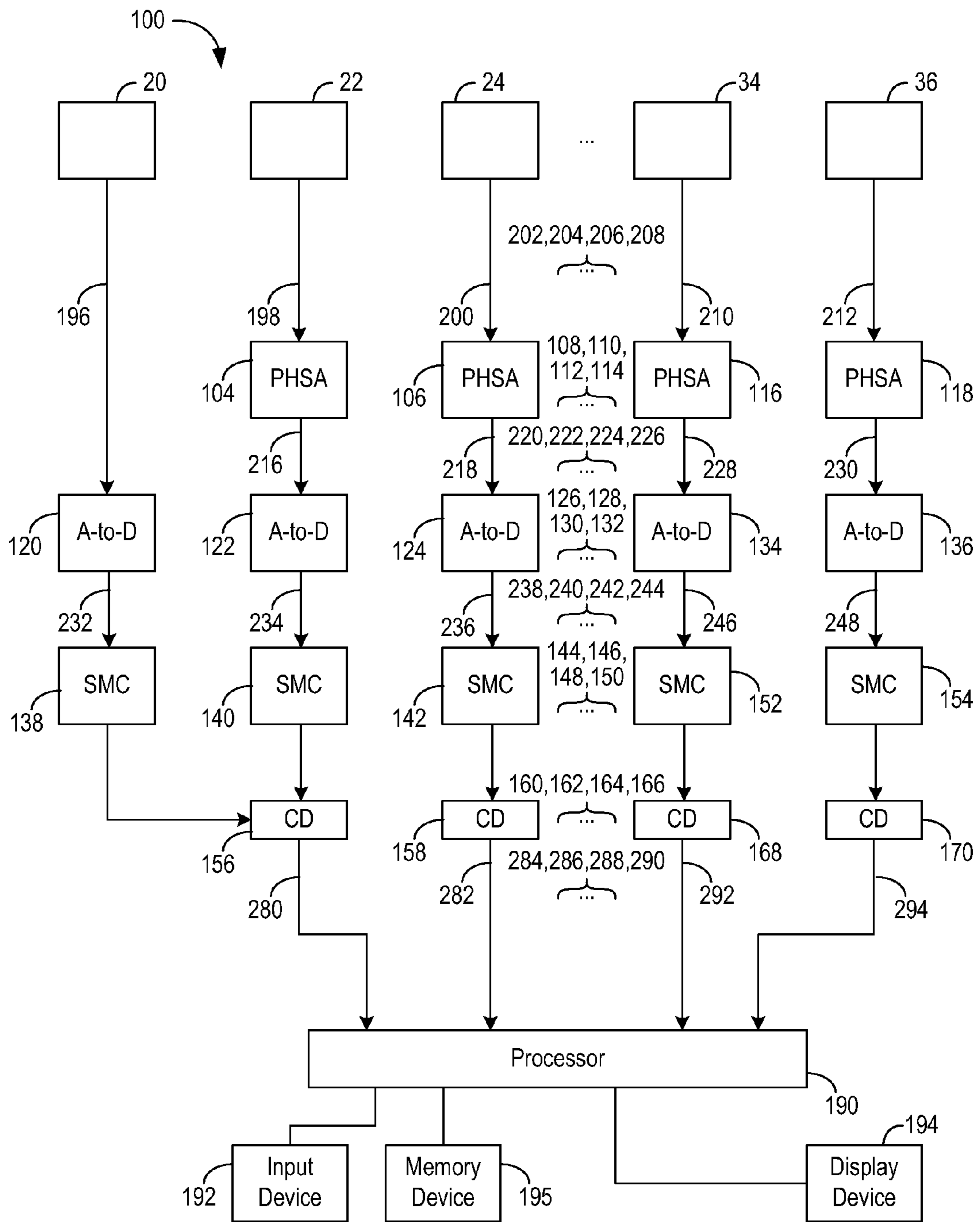


FIG. 2

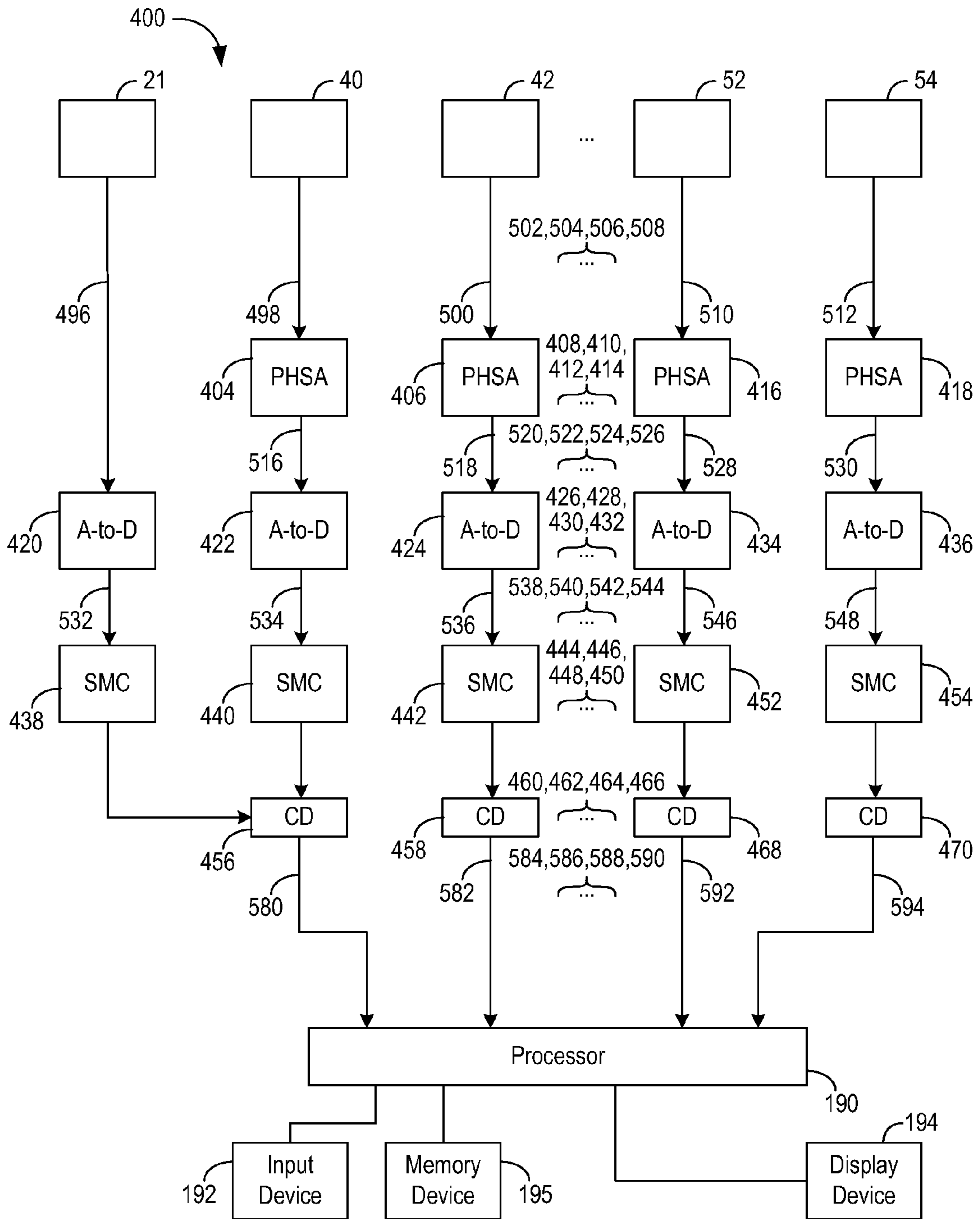


FIG. 3

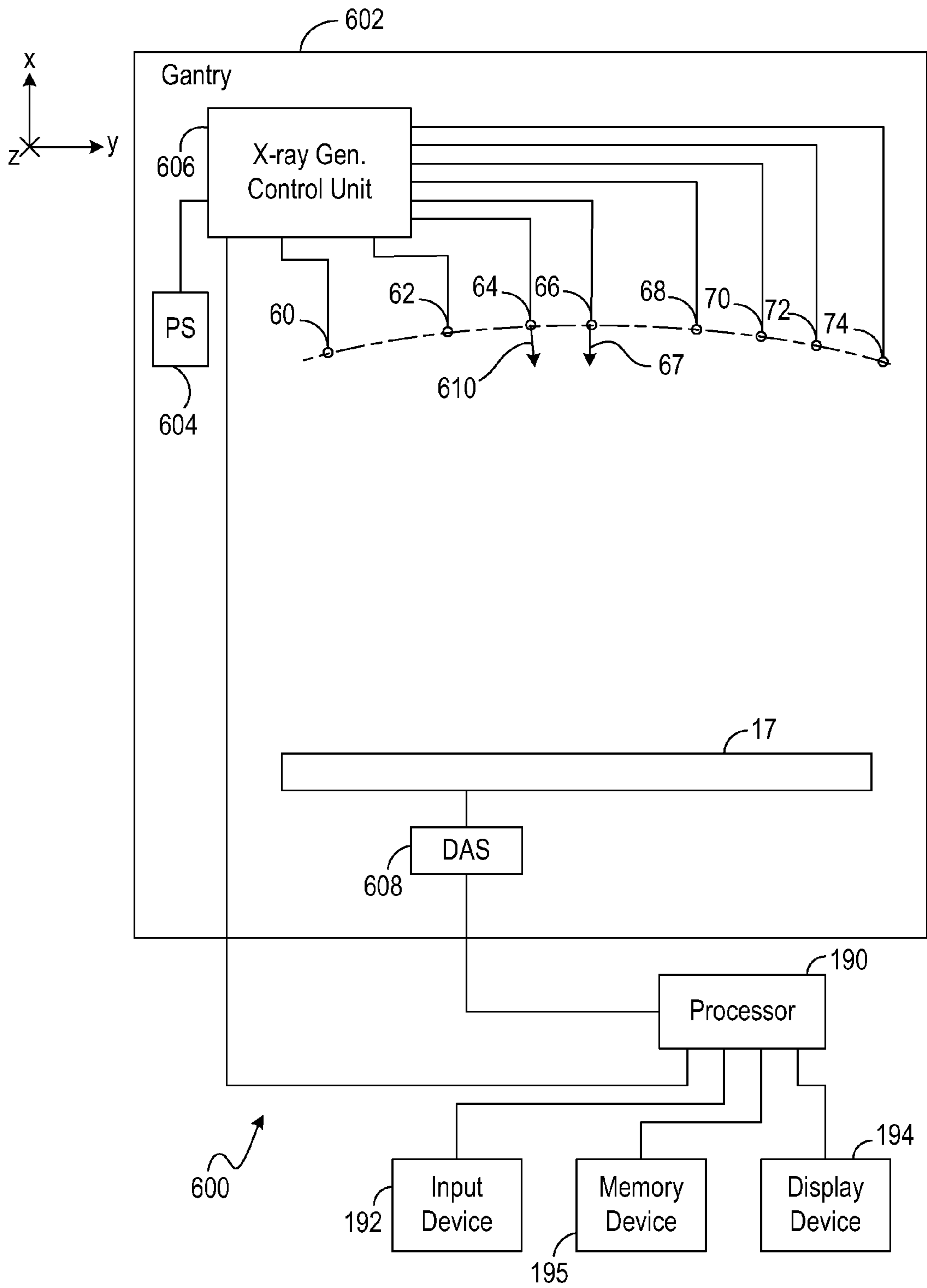


FIG. 4

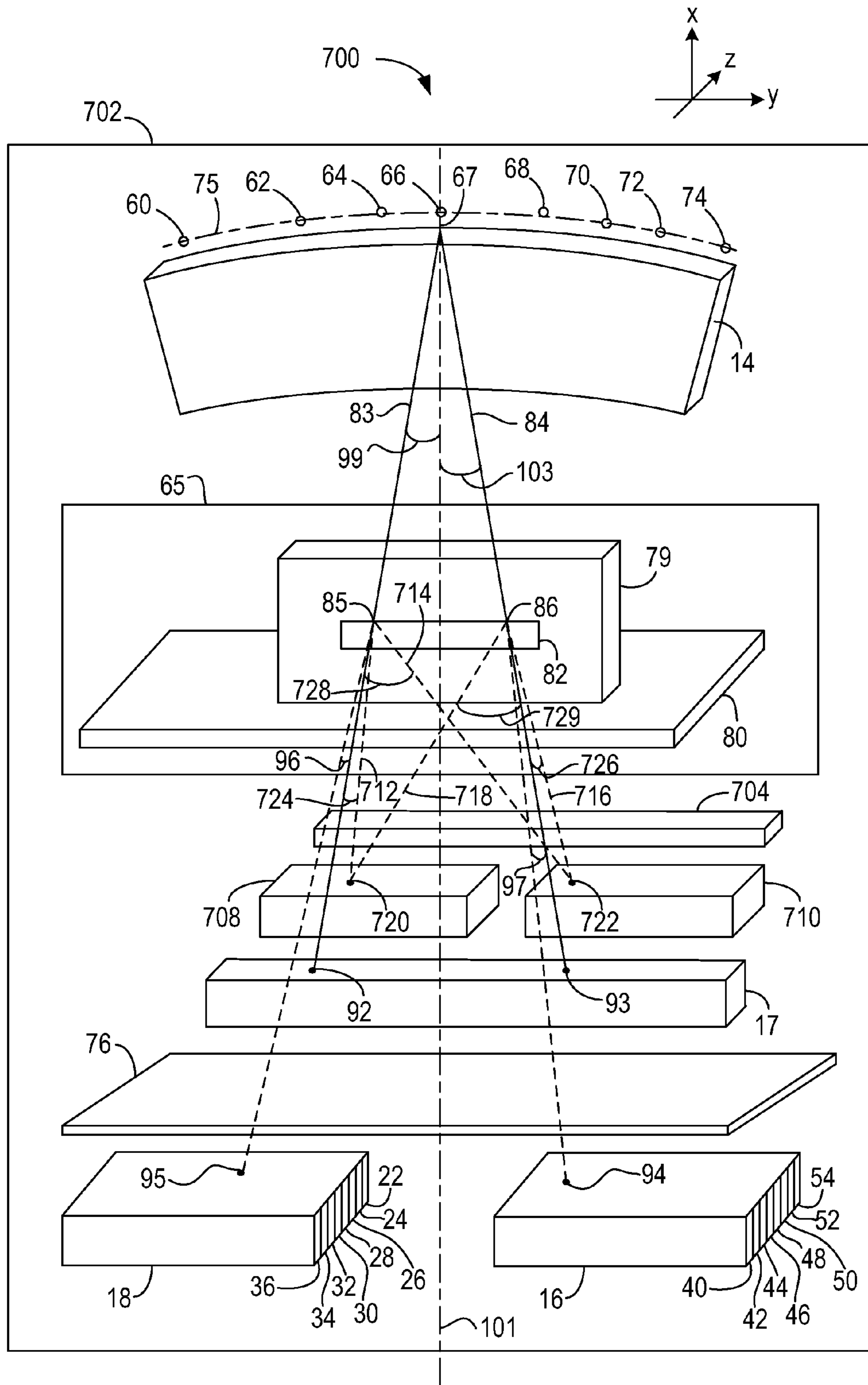


FIG. 5

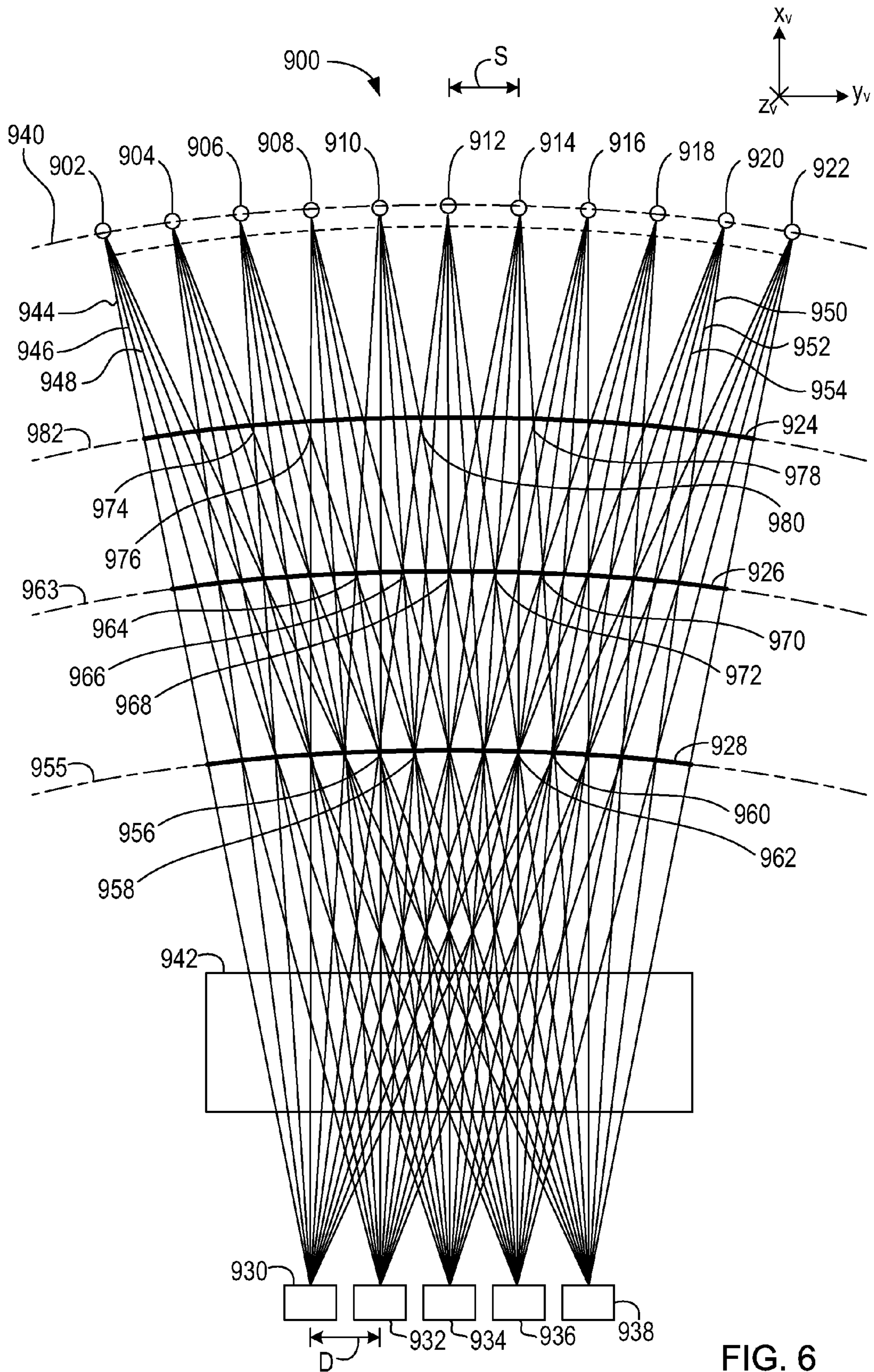


FIG. 6

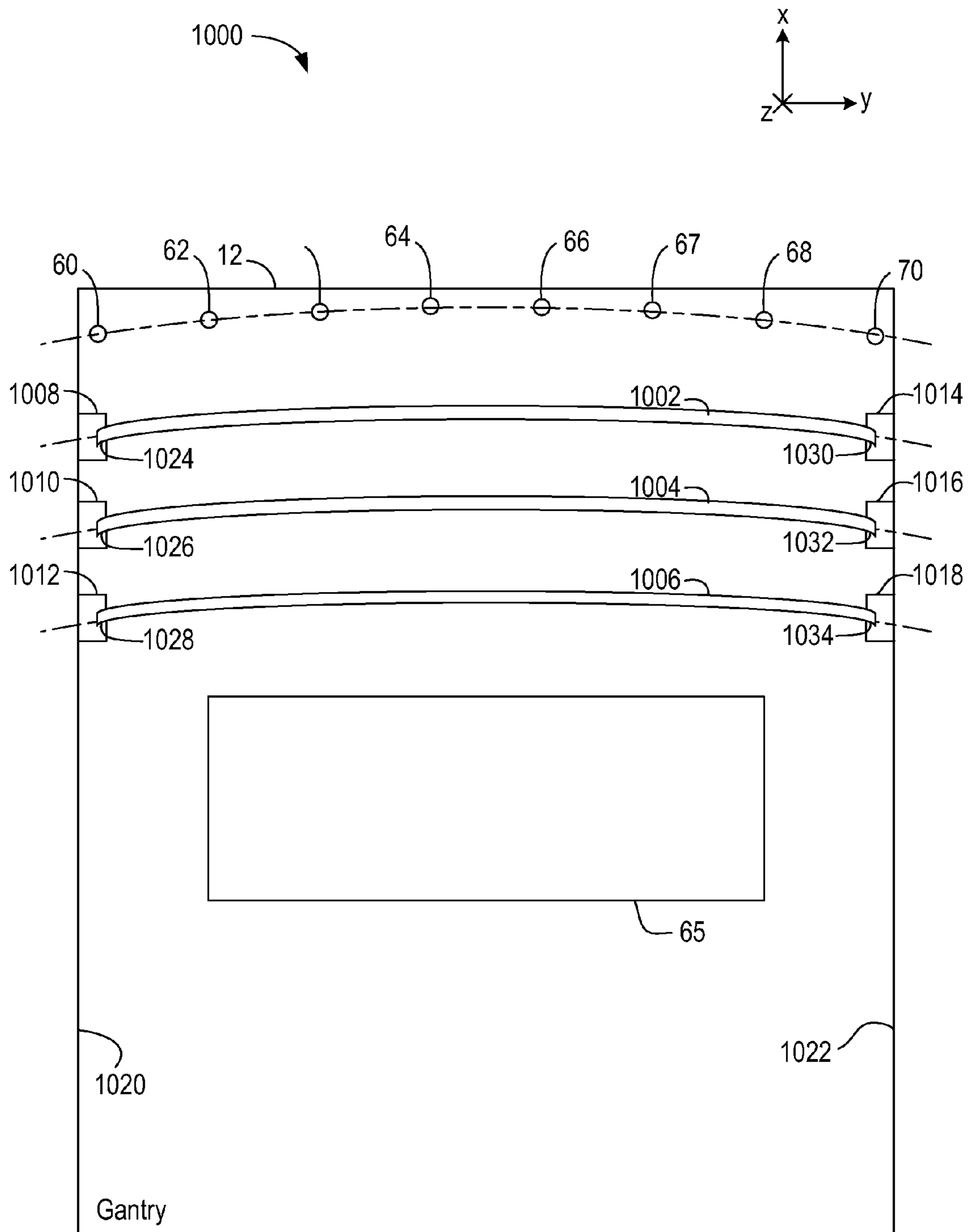


FIG. 7

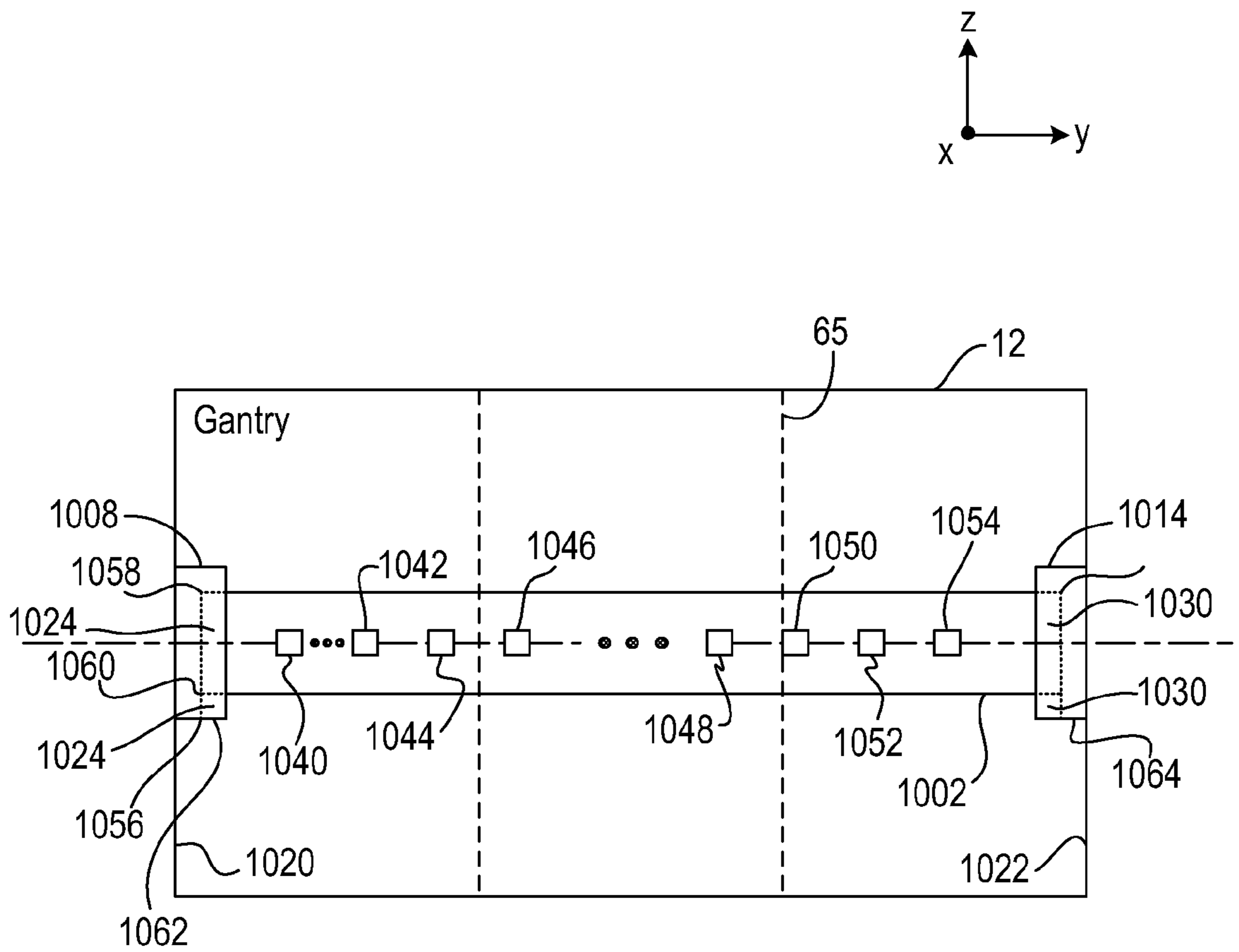


FIG. 8

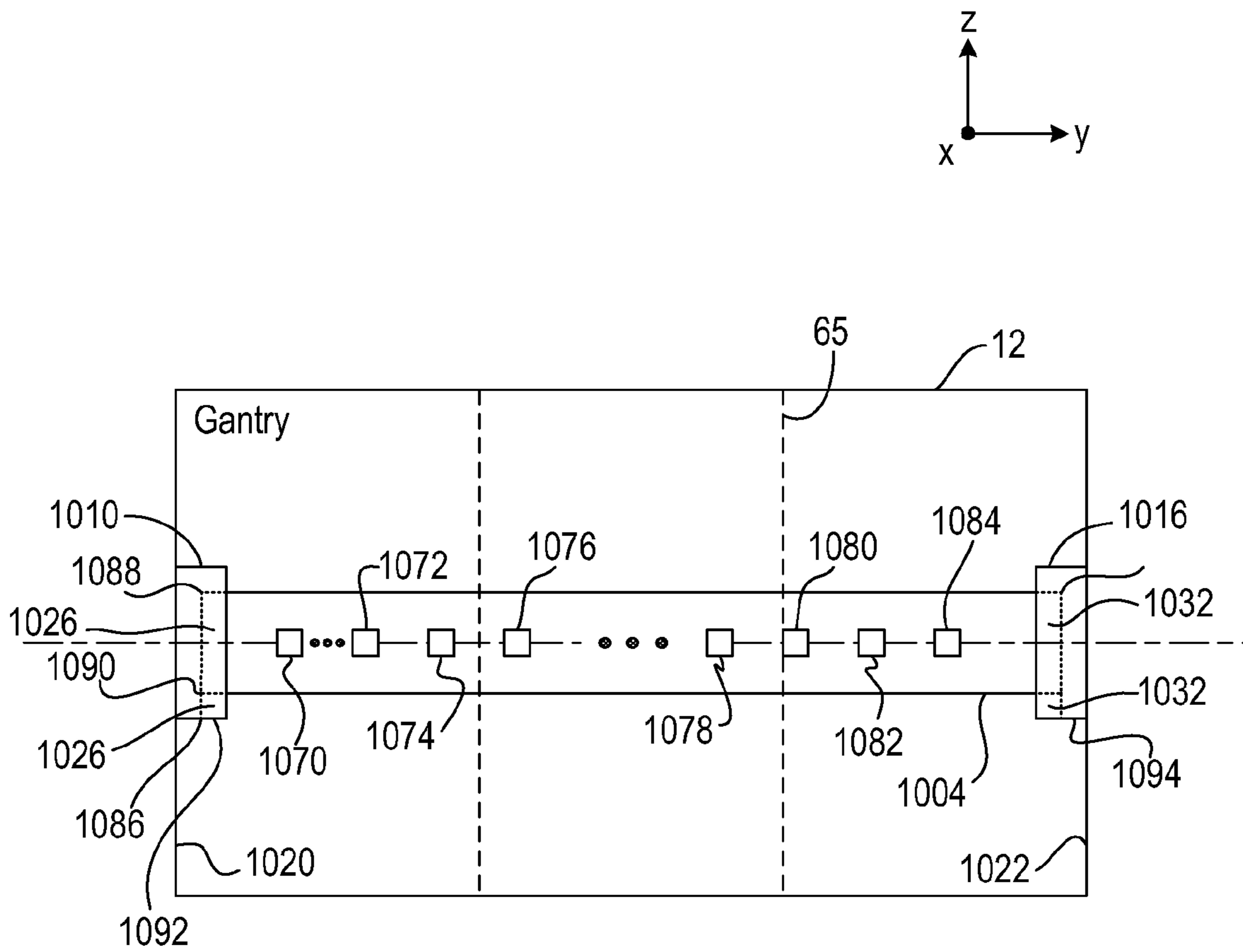


FIG. 9

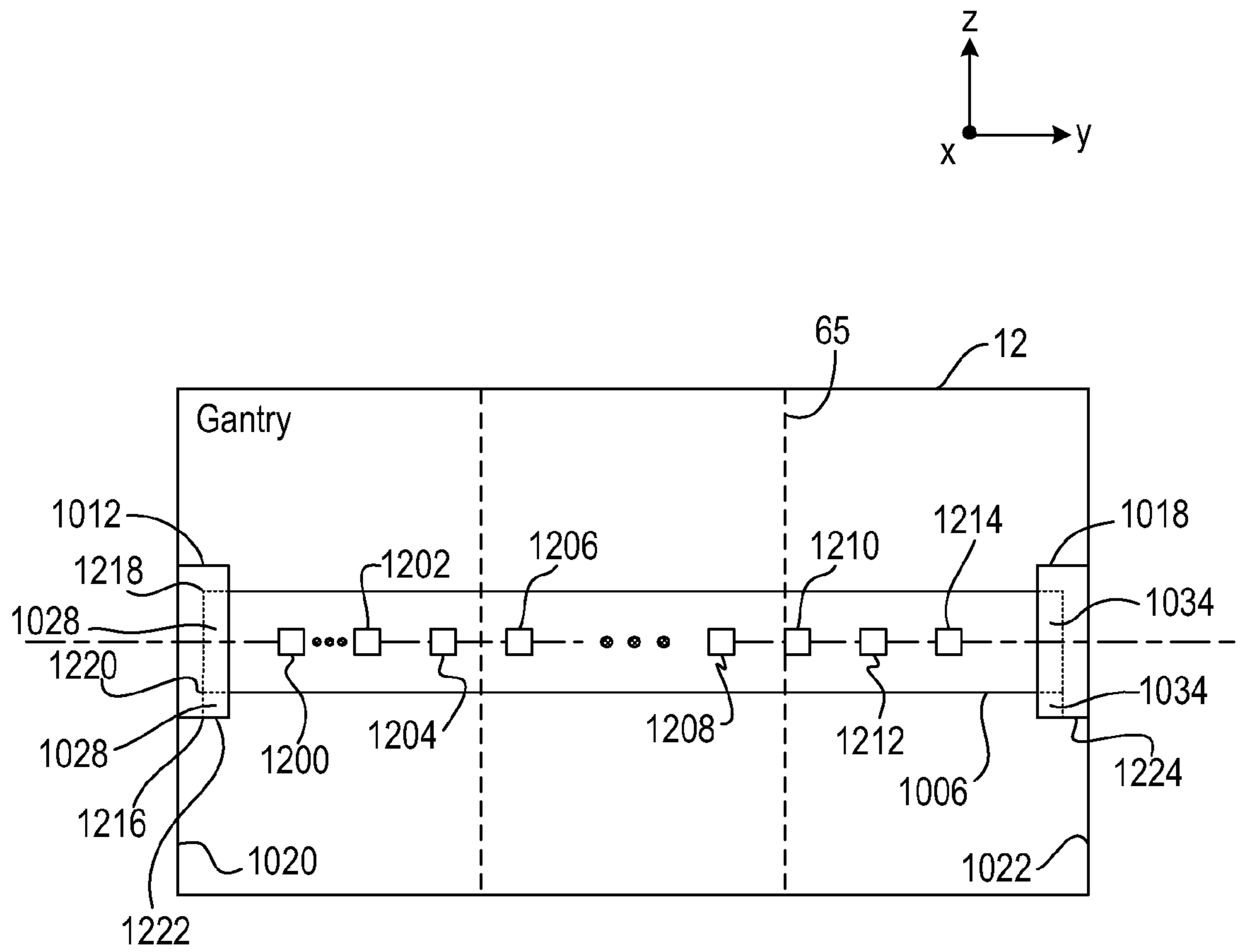


FIG. 10

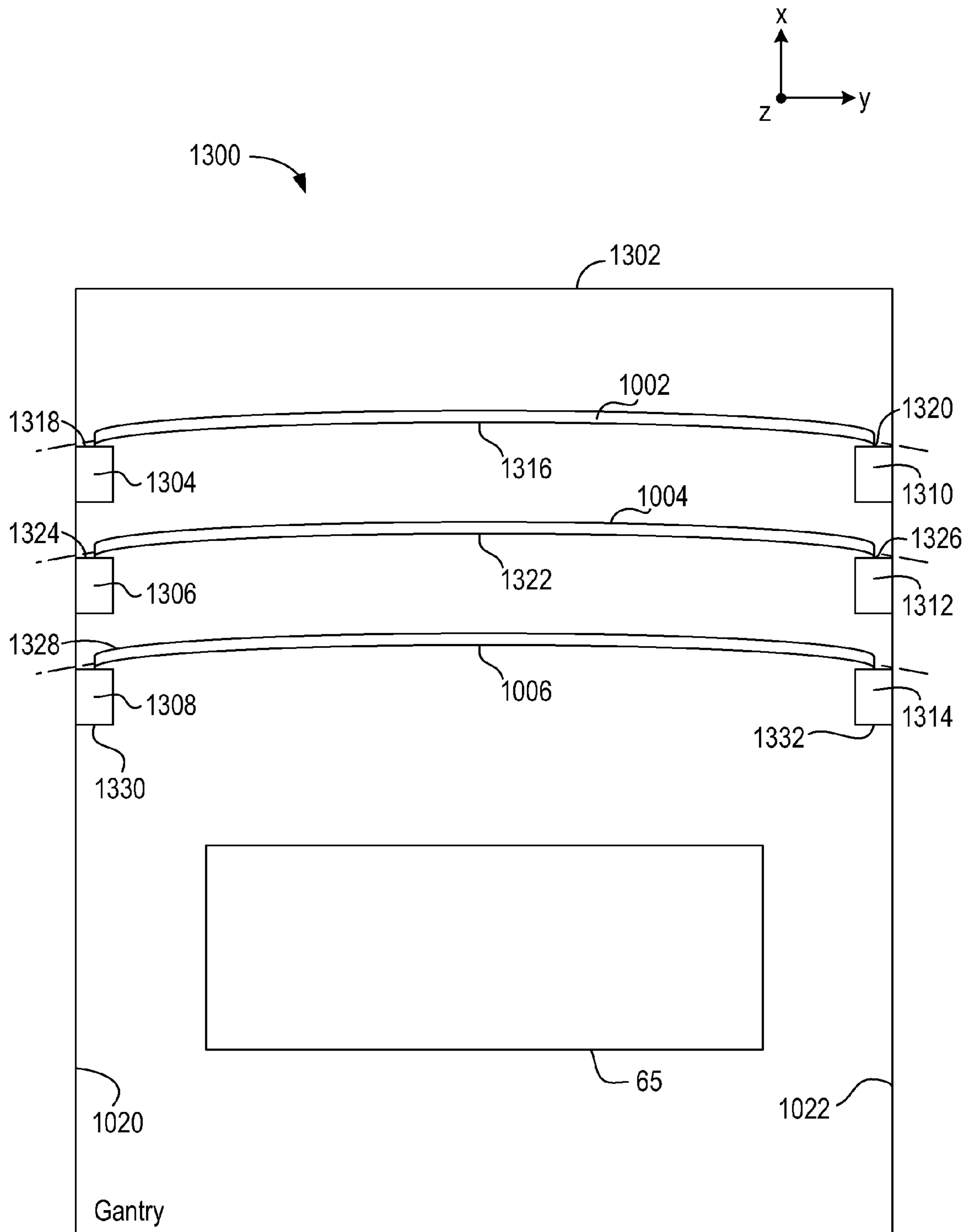


FIG. 11

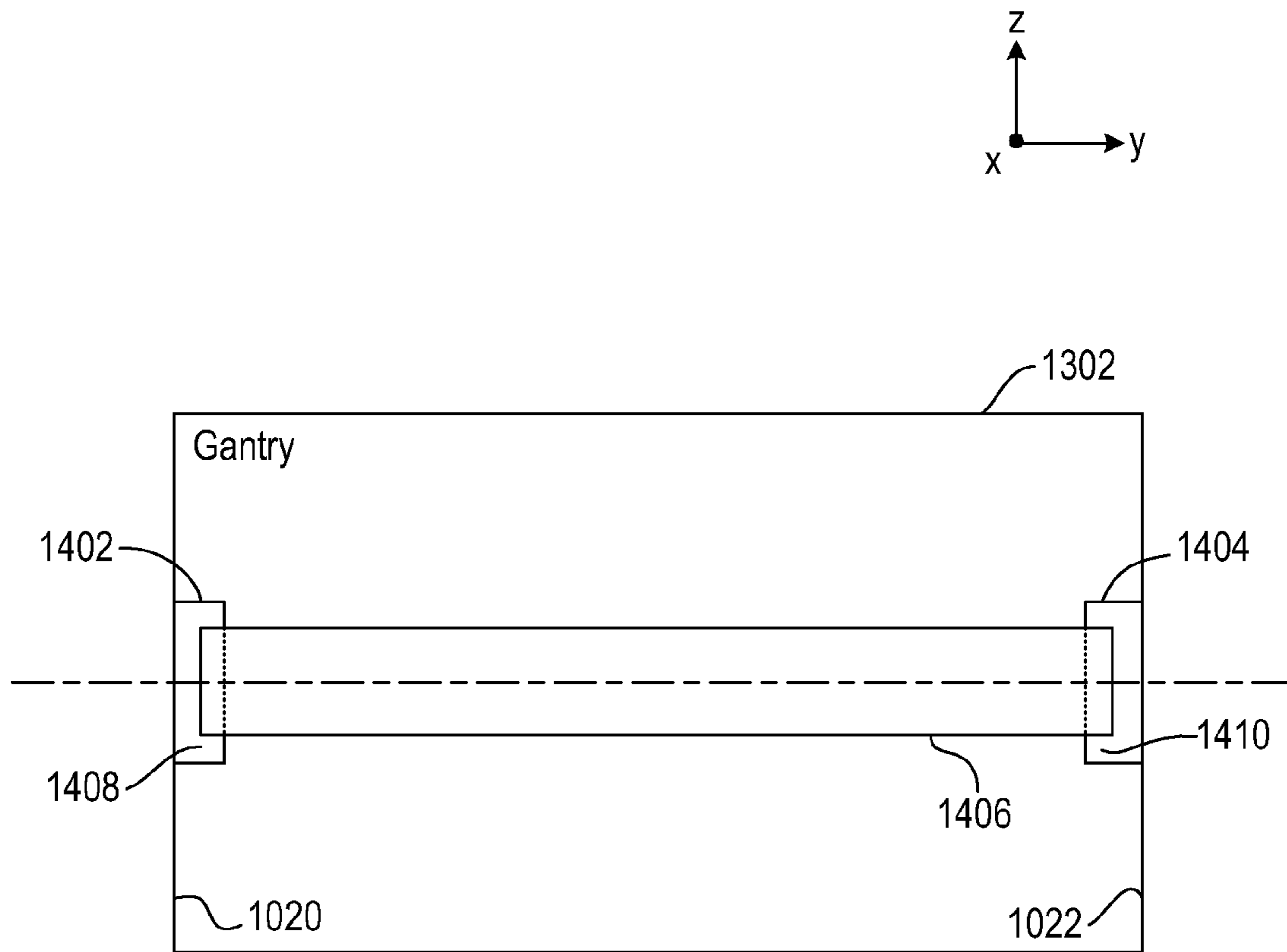


FIG. 12

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SYSTEMS AND METHODS FOR GENERATING AN IMPROVED DIFFRACTION PROFILE

BACKGROUND OF THE INVENTION

This invention relates generally to systems and methods for generating a diffraction profile and more particularly to systems and methods for generating an improved diffraction profile.

The events of Sep. 11, 2001 instigated an urgency for more effective and stringent screening of airport baggage. The urgency for security expanded from an inspection of carry-on bags for knives and guns to a complete inspection of checked bags for a range of hazards with particular emphasis upon concealed explosives. X-ray imaging is a widespread technology currently employed for screening. However, existing x-ray baggage scanners, including computed tomography (CT) systems, designed for detection of explosive and illegal substances are unable to discriminate between harmless materials in certain ranges of density and threat materials like plastic explosive.

A plurality of identification systems based on a plurality of x-ray diffraction (XRD) techniques provide an improved discrimination of materials compared to that provided by the x-ray baggage scanners. The XRD identification systems measure a plurality of d-spacings between a plurality of lattice planes of micro-crystals in materials.

However, the XRD identification systems are inefficient because the XRD identification systems consume a high amount of power. Moreover, it is difficult for the XRD identification systems to examine a large suitcase.

BRIEF DESCRIPTION OF THE INVENTION

In one aspect, a system for generating an improved diffraction profile is described. The system includes at least one x-ray source configured to generate x-rays and a primary collimator outputting a first x-ray beam to a first focus point and a second x-ray beam to a second focus point. The primary collimator generates the first and second x-ray beams from the x-rays. The system further includes a container, a first scatter detector configured to detect a first set of scattered radiation generated upon intersection of the first x-ray beam with the container and to detect a second set of scattered radiation generated upon intersection of the second x-ray beam with the container. An angle of scatter of the first set of scattered radiation detected by the first scatter detector is at most half of an angle of scatter of the second set of scattered radiation detected by the first scatter detector.

In another aspect, a system for generating an improved diffraction profile is described. The system includes at least one x-ray source configured to generate x-rays and a primary collimator outputting a first x-ray beam to a first focus point and a second x-ray beam to a second focus point. The primary collimator generates the first and second x-ray beams from the x-rays. The system further includes a container, and a first scatter detector configured to detect a first set of scattered radiation generated upon intersection of the first x-ray beam with the container and to detect a second set of scattered radiation generated upon intersection of the second x-ray beam with the container. An angle of scatter of the first set of scattered radiation detected by the first scatter detector is at most half of an angle of scatter of the second set of scattered radiation detected by the first scatter detector. The system also includes a processor coupled to the first scatter detector and

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configured to generate a portion of a diffraction profile from the first and second sets of scattered radiation detected by the first scatter detector

In yet another aspect, a method for generating an improved diffraction profile is described. The method includes generating x-rays by activating at least one x-ray source and outputting, by a primary collimator, a first x-ray beam to a first focus point and a second x-ray beam to a second focus point. The primary collimator generates the first and second x-ray beams from the x-rays. The method further includes detecting, by a first scatter detector, a first set of scattered radiation generated upon intersection of the first x-ray beam with a container and detecting, by the first scatter detector, a second set of scattered radiation generated upon intersection of the second x-ray beam with the container. An angle of scatter of the first set of scattered radiation detected by the first scatter detector is at most half of an angle of scatter of the second set of scattered radiation detected by the first scatter detector.

BRIEF DESCRIPTION OF THE DRAWINGS

FIG. 1 is an isometric view of an embodiment of a system for generating an improved diffraction profile of a substance.

FIG. 2 is a block diagram of an embodiment of a system for generating an improved diffraction profile of a substance.

FIG. 3 is a block diagram of an embodiment of a system for generating an improved diffraction profile of a substance.

FIG. 4 is a block diagram of an embodiment of a system for generating an x-ray image.

FIG. 5 is an isometric view of an alternative embodiment of a system for generating an improved diffraction profile of a substance.

FIG. 6 is a diagram of illustrating an embodiment of a virtual system for developing a primary collimator of the system of FIG. 1.

FIG. 7 is a diagram of an embodiment of a system implementing the primary collimator.

FIG. 8 is a top view of an embodiment of a gantry of the system of FIG. 1.

FIG. 9 is another top view of an embodiment of the gantry.

FIG. 10 is yet another top view of an embodiment of the gantry.

FIG. 11 is a diagram of an alternative embodiment of a gantry.

FIG. 12 is a top view of the gantry of FIG. 11.

DETAILED DESCRIPTION OF THE INVENTION

FIG. 1 is an isometric view of an embodiment of a system 10 for generating an improved diffraction profile of a substance. System 10 includes a gantry 12. Gantry 12 includes a primary collimator 14, a scatter detector 16, a transmission detector 17, a scatter detector 18, and a secondary collimator 76. Each scatter detector 16 and 18 is a segmented semiconductor detector.

Transmission detector 17 includes a plurality of detector elements, such as detector elements 20 and 21. Scatter detector 18 includes a plurality of detector cells or detector elements 22, 24, 26, 28, 30, 32, 34, and 36 for detecting coherent scatter. Scatter detector 16 includes a plurality of detector cells or detector elements 40, 42, 44, 46, 48, 50, 52, and 54 for detecting coherent scatter. Each of scatter detectors 16 and 18 include any number, such as, ranging from and including 5 to 1200, of detector elements. For example, scatter detector 18 includes a number, such as ranging from and including 5 to 40, of detector elements in a z-direction parallel to a z-axis, and a number, such as ranging from and including 1 to 30

detector elements in a y-direction parallel to a y-axis. An x-axis, the y-axis, and the z-axis are located within an xyz co-ordinate system. The x-axis is perpendicular to the y-axis and the z-axis, and the y-axis is perpendicular to the z-axis, and the x-axis is parallel to an x-direction. X-ray sources, of system 10, including x-ray sources 60, 62, 64, 66, 68, 70, 72, and 74, and transmission detector 17 form an inverse single-pass multi-focus imaging system. X-ray sources, of system 10, including x-ray sources 60, 62, 64, 66, 68, 70, 72, and 74, have an inverse fan-beam geometry that includes a symmetric location of the x-ray sources relative to the z-axis. A number of detector elements within scatter detector 16 is the same as a number of detector elements within scatter detector 18.

Scatter detector 16 is separate from scatter detector 18. For example, scatter detector 16 has a housing that is separate from a housing of scatter detector 18. As another example scatter detectors 16 and 18 are separated from each other by a gap. As yet another example, a shortest distance 56 between a center of scatter detector 16 and a center of scatter detector 18 ranges from and including 40 millimeters (mm) to 200 mm. Each of scatter detector 16, scatter detector 18, and transmission detector 17 are located in the same yz plane. The yz plane is formed by the y-axis and the z-axis. Each of scatter detector 16 and scatter detector 18 is separate from transmission detector 17 by a shortest distance ranging from and including 30 mm to 60 mm in the z-direction.

Gantry 12 further includes a plurality of x-ray sources 60, 62, 64, 66, 68, 70, 72, and 74. X-ray sources 60, 62, 64, 66, 68, 70, 72, and 74 are located parallel to and coincident with an arc 75. It is noted that in an alternative embodiment, system 10 includes a higher number, such as 10 or 20, or alternatively a lower number, such as 4 or 6, of x-ray sources than that shown in FIG. 1. A center of transmission detector 17 is located at a center of circle having arc 75. Each x-ray source 60, 62, 64, 66, 68, 70, 72, and 74 is an x-ray source that includes a cathode and an anode. Alternatively, each x-ray source 60, 62, 64, 66, 68, 70, 72, and 74 is an x-ray source that includes a cathode and all x-ray sources 60, 62, 64, 66, 68, 70, 72, and 74 share a common anode.

A container 79 is placed on a support 80 between x-ray sources 60, 62, 64, 66, 68, 70, 72, and 74 and scatter detectors 16 and 18. Container 79 and support 80 are located within an opening 65 of gantry 12. Examples of container 79 include a bag, a box, and an air cargo container 79. Examples of each x-ray source 60, 62, 64, 66, 68, 70, 72, and 74 include a polychromatic x-ray source. Container 79 includes a substance 82. Examples of substance 82 include an organic explosive, an amorphous substance having a crystallinity of less than twenty five percent, a quasi-amorphous substance having a crystallinity at least equal to twenty-five percent and less than fifty percent, and a partially crystalline substance having a crystallinity at least equal to fifty percent and less than one-hundred percent. Examples of the amorphous, quasi-amorphous, and partially crystalline substances include a gel explosive, a slurry explosive, an explosive including ammonium nitrate, and a special nuclear material. Examples of the special nuclear material include plutonium and uranium. Examples of support 80 include a table and a conveyor belt. An example of each scatter detector 16 and 18 includes a segmented detector fabricated from Germanium.

X-ray source 66 emits an x-ray beam 67 in an energy range, which is dependent on a voltage applied by a power source to x-ray source 66. Primary collimator 14 generates two primary beams 83 and 84, such as pencil beams, upon collimating x-ray beam 67 from x-ray source 66. In an alternative embodiment, primary collimator 14 collimates x-ray beam 67 received from x-ray source 66 to generate a plurality, such as

three or four, primary beams. A number of primary beams generated by primary collimator 14 is equal to or alternatively greater than a number of scatter detectors on one side of transmission detector 17 and on one side of the y-axis. Primary beams 83 and 84 pass through a plurality of points 85 and 86 on substance 82 within container 79 arranged on support 80 to generate scattered radiation 88, 89, 90, and 91. For example, primary beam 83 passes through point 85 to generate scattered radiation 88 and 89. As another example, primary beam 84 passes through point 86 to generate scattered radiation 90 and 91.

Secondary collimator 76 is located between support 80 and a set of scatter detectors 16 and 18. Secondary collimator 76 includes a number of collimator elements, such as sheets, slits, or laminations, to ensure that scattered radiation arriving at scatter detectors 16 and 18 have constant scatter angles with respect to primary beams 83 and 84 and that a position of scatter detectors 16 and 18 permits a depth in container 79 at which the scattered radiation originated to be determined. For example, the collimator elements of secondary collimator 76 are arranged parallel to a direction of scattered radiation 88 and of scattered radiation 90 to absorb scattered radiation that is not parallel to the direction of the scattered radiation 88 and of scattered radiation 90.

The number of collimator elements in secondary collimator 76 provided is equal to or alternatively greater than a number of detector elements of any one of scatter detectors 16 and 18 and the collimator elements are arranged such that scattered radiation between neighboring collimator elements is incident on one of the detector elements. The collimator elements of scatter detectors 16 and 18 are made of a radiation-absorbing material, such as, steel, copper, silver, or tungsten.

Underneath support 80, there is arranged transmission detector 17, which measures an intensity of primary beam 83 at a point 92 on transmission detector 17 and an intensity of primary beam 84 at a point 93 on transmission detector 17. Moreover, underneath support 80, there are arranged scatter detectors 16 and 18 that measure photon energies of scattered radiation received by scatter detectors 16 and 18. Each of scatter detectors 16 and 18 measures the x-ray photons within scattered radiation received by scatter detectors 16 and 18 in an energy-sensitive manner by outputting a plurality of electrical output signals linearly dependent on a plurality of energies of the x-ray photons detected from within the scattered radiation. Scatter detector 16 measures scattered radiation 90 received at a point 94 on scatter detector 16 and scatter detector 18 measures scattered radiation 88 received at a point 95 on scatter detector 18. An example of a shortest distance between points 85 and 95 includes a distance ranging from and including 900 mm to 1100 mm. An example of a distance between points 95 and 92 includes a distance ranging from and including 25 mm to 80 mm.

Scatter detectors 16 and 18 detect scattered radiation to generate a plurality of electrical output signals. Scatter detector 16 detects scattered radiation 90 generated upon intersection of primary beam 84 with point 86. Moreover, scatter detector 16 detects scattered radiation 89 generated upon intersection of primary beam 83 with point 85. Scatter detector 18 detects scattered radiation 88 generated upon intersection of primary beam 83 with point 85. Moreover, scatter detector 18 detects scattered radiation 91 generated upon intersection of primary beam 84 with point 86. A scatter angle 96 formed between primary beam 83 and scattered radiation 88 is equal to a scatter angle 97 formed between primary beam 84 and scattered radiation 90. An example of each of scatter angles 96 and 97 includes an angle ranging from and

including 0.025 radians to 0.045 radians. An example of a scatter angle **98** formed between primary beam **83** and scattered radiation **89** ranges from and including 0.05 radians to 0.09 radians. Moreover, an example of a scatter angle **105** formed between primary beam **84** and scattered radiation **91** ranges from and including 0.05 radians to 0.09 radians. Scatter angle **98** is at least twice of each scatter angle **96** and **97** and scatter angle **105** is at least twice of each scatter angle **96** and **97**. An angle **99** formed by primary beam **83** with respect to a center **101** between scatter detectors **16** and **18** is equal to an angle **103** formed by primary beam **84** with respect to center **101**. In another alternative embodiment, system **10** includes additional scatter detectors other than scatter detectors **16** and **18**. The additional scatter detectors are placed on a side of transmission detector **17** that is the same as a side of placement of scatter detectors **16** and **18**. Moreover, the additional scatter detectors are the same as scatter detectors **16** and **18**. For example, any one of the additional scatter detectors have the same number of detector elements as that of any of scatter detectors **16** and **18**.

FIG. 2 is diagram of an embodiment of a system **100** for generating an improved diffraction profile of a substance. System **100** includes detector element **20** of transmission detector **17**, scatter detector elements **22**, **24**, **26**, **28**, **30**, **32**, **34**, and **36**, a plurality of pulse-height shaper amplifiers (PHSA) **104**, **106**, **108**, **110**, **112**, **114**, **116**, and **118**, a plurality of analog-to-digital (A-to-D) converters **120**, **122**, **124**, **126**, **128**, **130**, **132**, **134**, and **136**, a plurality of spectrum memory circuits (SMCs) **138**, **140**, **142**, **144**, **146**, **148**, **150**, **152**, and **154** allowing pulse height spectra to be acquired, a plurality of correction devices (CDs) **156**, **158**, **160**, **162**, **164**, **166**, **168**, and **170**, a processor **190**, an input device **192**, a display device **194**, and a memory device **195**. As used herein, the term processor is not limited to just those integrated circuits referred to in the art as a processor, but broadly refers to a computer, a microcontroller, a microcomputer, a programmable logic controller, an application specific integrated circuit, and any other programmable circuit. The computer may include a device, such as, a floppy disk drive or CD-ROM drive, for reading data including the methods for developing a primary collimator from a computer-readable medium, such as a floppy disk, a compact disc-read only memory (CD-ROM), a magneto-optical disk (MOD), or a digital versatile disc (DVD). In another embodiment, processor **190** executes instructions stored in firmware. Examples of display device **194** include a liquid crystal display (LCD) and a cathode ray tube (CRT). Examples of input device **192** include a mouse and a keyboard. Examples of memory device **195** include a random access memory (RAM) and a read-only memory (ROM). An example of each of correction devices **156**, **158**, **160**, **162**, **164**, **166**, **168**, and **170** include a divider circuit. Each of spectrum memory circuits **138**, **140**, **142**, **144**, **146**, **148**, **150**, **152**, and **154** include an adder and a memory device, such as a RAM or a ROM.

Detector element **20** is coupled to analog-to-digital converter **120**, and detector elements **22**, **24**, **26**, **28**, **30**, **32**, **34**, and **36** are coupled to pulse-height shaper amplifiers **104**, **106**, **108**, **110**, **112**, **114**, **116**, and **118**, respectively. Detector element **20** generates an electrical output signal **196** by detecting primary beam **83** and detector elements **22**, **24**, **26**, **28**, **30**, **32**, **34**, and **36** generate a plurality of electrical output signals **198**, **200**, **202**, **204**, **206**, **208**, **210**, and **212** by detecting scattered radiation. For example, detector element **22** generates electrical output signal **198** for each scattered x-ray photon incident on detector element **22**. Each pulse-height shaper amplifier amplifies an electrical output signal received from a detector element. For example, pulse-height shaper

amplifier **104** amplifies electrical output signal **198** and pulse-height shaper amplifier **106** amplifies electrical output signal **200**. Pulse-height shaper amplifiers **104**, **106**, **108**, **110**, **112**, **114**, **116**, and **118** have a gain factor determined by processor **190**.

An amplitude of an electrical output signal output from a detector element is proportional to an energy of an x-ray quantum that is detected by the detector element to generate the electrical output signal. For example, an amplitude of electrical output signal **196** is proportional to an energy of an x-ray quantum in primary beam **83** detected by detector element **20**. As another example, an amplitude of electrical output signal **198** is proportional to an energy of an x-ray quantum within scattered radiation that is detected by detector element **22**.

A pulse-height shaper amplifier generates an amplified output signal by amplifying an electrical output signal generated from a detector element. For example, pulse-height shaper amplifier **104** generates an amplified output signal **216** by amplifying electrical output signal **198** and pulse-height shaper amplifier **106** generates an amplified output signal **218** by amplifying electrical output signal **200**. Similarly, a plurality of amplified output signals **220**, **222**, **224**, **226**, **228**, and **230** are generated. An analog-to-digital converter converts an output signal from an analog form to a digital form to generate a digital output signal. For example, analog-to-digital converter **120** converts electrical output signal **196** from an analog form to a digital format to generate a digital output signal **232** and analog-to-digital converter **122** converts amplified output signal **216** from an analog form to a digital format to generate a digital output signal **234**. Similarly, a plurality of digital output signals **236**, **238**, **240**, **242**, **244**, **246**, and **248** are generated by analog-to-digital converters **124**, **126**, **128**, **130**, **132**, **134**, and **136**, respectively. A digital value of a digital output signal generated by an analog-to-digital converter represents an amplitude of energy of a pulse of an amplified output signal. Each pulse is generated by an x-ray quantum, such as an x-ray photon. For example, a digital value of digital output signal **234** output by analog-to-digital converter **122** is a value of an amplitude of a pulse of amplified output signal **216**.

An adder of a spectrum memory circuit adds a number of pulses in a digital output signal. For example, when analog-to-digital converter **122** converts a pulse of amplified output signal **216** into digital output signal **234** to determine an amplitude of the pulse of amplified output signal **216**, an adder within spectrum memory circuit **140** increments, by one, a value within a memory device of spectrum memory circuit **140**. Accordingly, at an end of an x-ray examination of substance **82**, a memory device within a spectrum memory circuit stores a number of x-ray quanta detected by a detector element. For example, a memory device within spectrum memory circuit **142** stores a number of x-ray photons detected by detector element **24** and each of the x-ray photons has an amplitude of energy or alternatively an amplitude of intensity that is determined by analog-to-digital converter **124**.

A correction device receives a number of x-ray quanta that have a range of energies and are stored within a memory device of one of spectrum memory circuits **140**, **142**, **144**, **146**, **148**, **150**, **152**, and **154**, and divides the number by a number of x-ray quanta having the range of energies received from a memory device of spectrum memory circuit **138**. For example, correction device **156** receives a number of x-ray photons having a range of energies from a memory device of spectrum memory circuit **140**, and divides the number by a number of x-ray photons having the range received from a

memory device of spectrum memory circuit **138**. Each correction device outputs a correction output signal that represents a range of energies within x-ray quanta received by a detector element. For example, correction device **156** outputs a correction output signal **280** representing an energy spectrum or alternatively an intensity spectrum within x-ray quanta detected by detector element **22**. As another example, correction device **158** outputs correction output signal **282** representing an energy spectrum within x-ray quanta detector element **24**. Similarly, a plurality of correction output signals **284, 286, 288, 290, 292, and 294** are generated by correction devices **160, 162, 164, 166, 168, and 170**, respectively.

It is noted that a number of pulse-height shaper amplifiers **104, 106, 108, 110, 112, 114, 116, and 118** changes with a number of scatter detector elements **22, 24, 26, 28, 30, 32, 34, and 36**. For example, five pulse-height shaper amplifiers are used for amplifying signals received from five scatter detector elements. As another example, four pulse-height shaper amplifiers are used for amplifying signals received from four scatter detector elements. Similarly, a number of analog-to-digital converters **120, 122, 124, 126, 128, 130, 132, 134, and 136** changes with a number of detector elements **20, 22, 24, 26, 28, 30, 32, 34, and 36** and a number of spectrum memory circuits **138, 140, 142, 144, 146, 148, 150, 152, and 154** changes with the number of detector elements **20, 22, 24, 26, 28, 30, 32, 34, and 36**.

FIG. 3 is a diagram of an embodiment of a system **400** for generating an improved diffraction profile of a substance. System **400** includes detector element **21** of transmission detector **17**, scatter detector elements **40, 42, 44, 46, 48, 50, 52, and 54**, a plurality of pulse-height shaper amplifiers (PHSA) **404, 406, 408, 410, 412, 414, 416, and 418**, a plurality of analog-to-digital (A-to-D) converters **420, 422, 424, 426, 428, 430, 432, 434, and 436**, a plurality of spectrum memory circuits (SMCs) **438, 440, 442, 444, 446, 448, 450, 452, and 454** allowing pulse height spectra to be acquired, a plurality of correction devices (CDs) **456, 458, 460, 462, 464, 466, 468, and 470**, processor **190**, input device **192**, display device **194**, and memory device **195**. An example of each of correction devices **456, 458, 460, 462, 464, 466, 468, and 470** include a divider circuit. Each of spectrum memory circuits **438, 440, 442, 444, 446, 448, 450, 452, and 454** include an adder and a memory device, such as a RAM or a ROM.

Transmission detector element **21** generates an electrical output signal **496** by detecting primary beam **84** and scatter detector elements **40, 42, 44, 46, 48, 50, 52, and 54** generate a plurality of electrical output signals **498, 500, 502, 504, 506, 508, 510, and 512** by detecting scattered radiation. For example, transmission detector element **21** generates electrical output signal **496** for x-ray photons incident on transmission detector element **21**. Scatter detector elements **40, 42, 44, 46, 48, 50, 52, and 54** are coupled to pulse-height shaper amplifiers **404, 406, 408, 410, 412, 414, 416, and 418**, respectively. Each pulse-height shaped amplifier amplifies an electrical output signal received from a detector element. For example, pulse-height shaper amplifier **404** amplifies electrical output signal **498**. Pulse-height shaper amplifiers **404, 406, 408, 410, 412, 414, 416, and 418** have a gain factor determined by processor **190**.

An amplitude of an electrical output signal output from a detector element is proportional to an energy of an x-ray quantum that is detected by the detector element to generate the electrical output signal. For example, an amplitude of electrical output signal **496** is proportional to an energy of an x-ray quantum in primary beam **84** detected by detector element **21**. As another example, an amplitude of electrical out-

put signal **498** is proportional to an energy of an x-ray quantum within scattered radiation that is detected by detector element **40**.

A pulse-height shaper amplifier generates an amplified output signal by amplifying an electrical output signal generated from a detector element. For example, pulse-height shaper amplifier **404** generates an amplified output signal **516** by amplifying electrical output signal **498** and pulse-height shaper amplifier **406** generates an amplified output signal **518** by amplifying electrical output signal **500**. Similarly, a plurality of amplified output signals **518, 520, 522, 524, 526, 528, and 530** are generated. An analog-to-digital converter converts an output signal from an analog form to a digital form to generate a digital output signal. For example, analog-to-digital converter **420** converts electrical output signal **496** from an analog form to a digital format to generate a digital output signal **532** and analog-to-digital converter **422** converts amplified output signal **516** from an analog form to a digital format to generate a digital output signal **534**. Similarly, a plurality of digital output signals **536, 538, 540, 542, 544, 546, and 548** are generated by analog-to-digital converters **424, 426, 428, 430, 432, 434, and 436**, respectively. A digital value of a digital output signal generated by an analog-to-digital converter represents an amplitude of energy or alternatively an amplitude of intensity of a pulse of an amplified output signal. Each pulse is generated by an x-ray quantum, such as an x-ray photon. For example, a digital value of digital output signal **534** output by analog-to-digital converter **422** is a value of an amplitude of a pulse of amplified output signal **516**.

An adder of a spectrum memory circuit adds a number of pulses in a digital output signal. For example, when analog-to-digital converter **422** converts a pulse of amplified output signal **516** into digital output signal **534** to determine an amplitude of the pulse of amplified output signal **516**, an adder within spectrum memory circuit **440** increments, by one, a value within a memory device of spectrum memory circuit **440**. Accordingly, at an end of an x-ray examination of substance **82**, a memory device within a spectrum memory circuit stores a number of x-ray quanta detected by a detector element. For example, a memory device within spectrum memory circuit **442** stores a number of x-ray photons detected by detector element **42** and each of the x-ray photons has an amplitude of energy that is determined by analog-to-digital converter **424**.

A correction device receives a number of x-ray quanta that have a range of energies and are stored within a memory device of one of spectrum memory circuits **440, 442, 444, 446, 448, 450, 452, and 454**, and divides the number by a number of x-ray quanta having the range of energies received from a memory device of spectrum memory circuit **438**. For example, correction device **456** receives a number of x-ray photons having a range of energies from a memory device of spectrum memory circuit **440**, and divides the number by a number of x-ray photons having the range received from a memory device of spectrum memory circuit **438**. Each correction device outputs a correction output signal that represents a range of energies within x-ray quanta received by a detector element. For example, correction device **456** outputs a correction output signal **580** representing an energy spectrum or alternatively an intensity spectrum within x-ray quanta detected by detector element **40**. As another example, correction device **458** outputs correction output signal **582** representing an energy spectrum within x-ray quanta detected by detector element **42**. Similarly, a plurality of correction

output signals **584, 586, 588, 590, 592**, and **594** are generated by correction devices **460, 462, 464, 466, 468**, and **470**, respectively.

Processor **190** receives correction output signals **280, 282, 284, 286, 288, 290, 292, 294, 580, 582, 584, 586, 588, 590, 592**, and **594** to generate a momentum transfer x_A , measured in inverse nanometers (nm^{-1}), from an energy spectrum $r(E_A)$ of energy E_A of x-ray quanta within scattered radiation detected by scatter detectors **16** and **18** (FIG. 1). Processor **190** generates the momentum transfer x_A by applying

$$x_A = (E_A/hc)\sin(\theta/2) \quad (1)$$

where c is a speed of light, h is Planck's constant, θ represents constant scatter angles of x-ray quanta of scattered radiation detected by scatter detectors **16** and **18** (FIG. 1). Examples of θ include scatter angles **96** and **97** (FIG. 1). Processor **190** relates the energy E_A to the momentum transfer x_A by equation (1). Mechanical dimensions of secondary collimator **76** (FIG. 1) defines the scatter angle θ . The secondary collimator **76** (FIG. 1) restricts scattered radiation that does not have the angle θ . Processor **190** receives the scatter angle θ from a user, such as a human being, via input device **192**. Processor **190** generates a diffraction profile of substance **82** (FIG. 1) by calculating a number of scatter x-ray photons that are detected by scatter detectors **16** and **18** and by plotting the number versus the momentum transfer x_A .

It is noted that a number of pulse-height shape amplifiers **404, 406, 408, 410, 412, 414, 416**, and **418** changes with a number of scatter detector elements **40, 42, 44, 46, 48, 50, 52**, and **54**. For example, five pulse-height shaper amplifiers are used for amplifying signals received from five scatter detector elements. As another example, four pulse-height shaper amplifiers are used for amplifying signals received from four scatter detector elements. Similarly, a number of analog-to-digital converters **420, 422, 424, 426, 428, 430, 432, 434**, and **436** changes with a number of detector elements **21, 40, 42, 44, 46, 48, 50, 52**, and **54**, and a number of spectrum memory circuits **438, 440, 442, 444, 446, 448, 450, 452**, and **454** changes with the number of detector elements **21, 40, 42, 44, 46, 48, 50, 52**, and **54**.

FIG. 4 is a diagram of an embodiment of a system **600** for generating an x-ray image. System **600** includes a gantry **602**, processor **190**, input device **192**, display device **194**, and memory device **195**. Gantry **602** is an example of gantry **12** (FIG. 1). Gantry **602** includes a power supply **604**, an x-ray generation control unit **606**, x-ray sources **60, 62, 64, 66, 68, 70, 72**, and **74**, a data acquisition system (DAS) **608**, and transmission detector **17**. Alternatively, power supply **604** is located outside gantry **602**.

X-ray generation control unit **606** includes a pulse generator (not shown) that is coupled to processor **190** and that receives power from power supply **604**. Power supply **604** is coupled to x-ray sources **60, 62, 64, 66, 68, 70, 72**, and **74** to supply power to x-ray sources **60, 62, 64, 66, 68, 70, 72**, and **74**.

Processor **190** issues a command, such as a first on command, a second on command, a first off command, and a second off command. Upon receiving the first on command from processor **190**, the pulse generator generates a pulse and transmits the pulse to x-ray source **66**. Upon receiving a pulse from the pulse generator, x-ray source **66** generates x-ray beam **67** under a potential applied by power supply **604**. Similarly, upon receiving the first off command signal from processor **190**, the pulse generator stops transmitting a pulse to x-ray source **66** and x-ray source **66** stops generating x-ray beam **67**. Furthermore, upon receiving the second on command signal from processor **190**, the pulse generator gener-

ates and transmits a pulse to any one of the remaining x-ray sources **60, 62, 64, 68, 70, 72**, and **74** and any one of the remaining x-ray sources **60, 62, 64, 68, 70, 72**, and **74** generates an x-ray beam. For example, upon receiving the second on command signal from processor **190**, the pulse generator generates and transmits a pulse to x-ray source **64** and x-ray source **64** generates an x-ray beam **610**. Upon receiving the second off command signal from processor **190**, the pulse generator stops transmitting a pulse to any one of the remaining x-ray sources **60, 62, 64, 68, 70, 72**, and **74** and the one of the remaining x-ray sources **60, 62, 64, 68, 70, 72**, and **74** stops generating an x-ray beam.

DAS **608** samples analog data, such as electrical output signals, generated from a plurality of detector elements, including detector elements **20** and **21**, of transmission detector **17** and converts the analog data to a plurality of digital signals for subsequent processing.

FIG. 5 is an isometric view of an alternative embodiment of a system **700** for generating a diffraction profile of a substance. System **700** includes a gantry **702**. Gantry **702** includes x-ray sources **60, 62, 64, 66, 68, 70, 72**, and **74**, primary collimator **14**, secondary collimator **76**, scatter detectors **16** and **18**, transmission detector **17**, a secondary collimator **704**, and a plurality of scatter detectors **708** and **710** that detect coherent scatter. Gantry **702** is an example of gantry **12** (FIG. 1). Secondary collimator **704** has the same structure as that of secondary collimator **76**. Scatter detectors **708** and **710** are located on a side of transmission detector **17** and the side is opposite to a side where scatter detectors **16** and **18** are located. A number of scatter detectors on a side, with respect to transmission detector **17**, of placement of scatter detectors **16** and **18** is the same as a number of scatter detectors on a side, with respect to transmission detector **17**, of placement of scatter detectors **708** and **710**. For example, if five scatter detectors are placed on one side of transmission detector **17** where scatter detectors **16** and **18** are placed, five scatter detectors are placed on the other side of transmission detector **17** where scatter detectors **708** and **710** are placed. A shortest distance between a center of scatter detector **708** and a center of scatter detector **710** is the same as shortest distance **56** between a center of scatter detector **16** and a center of scatter detector **18**. Scatter detectors **708** and **710** are separated from each other by a gap. Each scatter detector **708** and **710** has the same number of detector elements as scatter detector **16**. A shortest distance of transmission detector **17** from any of scatter detectors **16, 18, 708**, and **710** is the same. For example, a shortest distance of transmission detector **17** from scatter detector **708** is equal to the shortest distance of transmission detector **17** from scatter detector **18**.

Primary beams **83** and **84** pass through points **85** and **86** on substance **82** to generate scattered radiation **88** (FIG. 1), **89** (FIG. 1), **90** (FIG. 1), **91** (FIG. 1), **712, 714, 716**, and **718**. For example, primary beam **83** passes through point **85** on substance **82** to generate scattered radiation **88** (FIG. 1), **89** (FIG. 1), **712** and **714**. As another example, primary beam **84** passes through point **86** on substance **82** to generate scattered radiation **90** (FIG. 1), **91** (FIG. 1), **716** and **718**.

Secondary collimator **704** is located between support **80** and a set of scatter detectors **708** and **710**. Secondary collimator **704** includes a number of collimator elements to ensure that scattered radiation arriving at scatter detectors **708** and **710** have constant scatter angles with respect to primary beams **83** and **84** and that a position of scatter detectors **708** and **710** permits a depth in container **79** at which the scattered radiation originated to be determined. For example, the collimator elements of secondary collimator **704** are arranged parallel to a direction of scattered radiation **712** and of scat-

tered radiation 716 to absorb scattered radiation that is not parallel to the direction of scattered radiation 712 and of scattered radiation 716.

The number of collimator elements in secondary collimator 704 provided is equal to or alternatively greater than a number of detector elements of one of scatter detectors 708 and 710 and the collimator elements are arranged such that scattered radiation between neighboring collimator elements is incident on one of the detector elements. The collimator elements of scatter detectors 708 and 710 are made of a radiation-absorbing material, such as, a copper alloy or a silver alloy.

Underneath support 80, there are arranged scatter detectors 708 and 710 that measure photon energies of scattered radiation detected by scatter detectors 708 and 710. Scatter detectors 16, 18, transmission detector 17, and scatter detectors 708 and 710 lie in the same yz plane. Each of scatter detectors 708 and 710 measures the x-ray photons within scattered radiation in an energy-sensitive manner by outputting a plurality of electrical output signals linearly dependent on a plurality of energies of the x-ray photons detected from within scattered radiation. Scatter detector 708 measures scattered radiation 712 received at a point 720 on scatter detector 708 and scatter detector 710 measures scattered radiation 716 received at a point 722 on scatter detector 710. An example of a shortest distance between points 85 and 720 includes a distance ranging from and including 900 mm to 1100 mm. An example of a distance between points 720 and 92 includes a distance ranging from and including 25 mm to 45 mm.

Scatter detectors 708 and 710 detect scattered radiation to generate a plurality of electrical output signals. Scatter detector 708 detects scattered radiation 712 generated upon intersection of primary beam 83 with point 85. Moreover, scatter detector 708 detects scattered radiation 718 generated upon intersection of primary beam 84 with point 86. Scatter detector 710 detects scattered radiation 716 generated upon intersection of primary beam 84 with point 86. Moreover, scatter detector 710 detects scattered radiation 714 generated upon intersection of primary beam 83 with point 85. A scatter angle 724 formed between primary beam 83 and scattered radiation 712 is equal to a scatter angle 726 formed between primary beam 84 and scattered radiation 716. An example of each of scatter angles 724 and 726 includes an angle ranging from and including 0.025 radians to 0.045 radians. An example of a scatter angle 728 formed between primary beam 83 and scattered radiation 714 ranges from and including 0.05 radians to 0.09 radians. Moreover, an example of a scatter angle 729 formed between primary beam 84 and scattered radiation 718 ranges from and including 0.05 radians to 0.09 radians. Scatter angle 728 is at least twice of each scatter angle 724 and 726 and scatter angle 729 is at least twice of each scatter angle 724 and 726. Angle 99 formed by primary beam 83 with respect to center 101 between scatter detectors 708 and 710 is equal to angle 103 formed by primary beam 84 with respect to center 101. In an alternative embodiment, system 700 does not include secondary collimators 76 and 704.

Scatter detector 708 is connected to a system similar to system 100 (FIG. 2) to generate a plurality of correction output signals, such as correction output signals 280, 282, 284, 286, 288, 290, 292, and 294 (FIG. 2). Moreover, scatter detector 710 is connected to a system similar to system 400 (FIG. 3) to generate a plurality of correction output signals, such as correction output signals 580, 582, 584, 586, 588, 590, 592, and 594 (FIG. 3). Processor 190 receives correction output signals 280, 282, 284, 286, 288, 290, 292, 294, 580, 582, 584, 586, 588, 590, 592, and 594 (FIGS. 2 and 3), the

correction output signals generated by the system that is similar to system 100 (FIG. 2) and that is connected to scatter detector 708, and the correction output signals generated by the system that is similar to system 400 (FIG. 3) and that is connected to scatter detector 710, to generate a momentum transfer x_B .

Processor 190 generates the momentum transfer x_B , measured in nm^{-1} , from an energy spectrum $r(E_B)$ of energy E_B of x-ray quanta within scattered radiation detected by scatter detectors 16, 18, 708, and 710. Processor 190 generates the momentum transfer x_B by applying

$$x_B = (E_B/hc)\sin(\theta/2) \quad (2)$$

where c is a speed of light, h is Planck's constant, θ represents constant scatter angles of x-ray quanta of scattered radiation detected by scatter detectors 16, 18, 708, and 710. Examples of θ include scatter angles 96 (FIG. 1), 97 (FIG. 1), 724, and 726. Processor 190 relates the energy E_B to the momentum transfer x_B by equation (2). The secondary collimators 76 (FIG. 1) and 704 restrict scattered radiation that does not have the angle θ . Processor 190 generates a diffraction profile of substance 82 by calculating a number of scatter x-ray photons that are detected by scatter detectors 16, 18, 708 and 710, and by plotting the number versus the momentum transfer x_B .

FIG. 6 is a diagram of illustrating an embodiment of a virtual system 900 for developing a primary collimator. Processor 190 generates virtual system 900. For example, processor 190 generates virtual system 900 to display virtual system 900 on display device 194 (FIG. 2). Virtual system 900 includes a plurality of virtual x-ray sources 902, 904, 906, 908, 910, 912, 914, 916, 918, 920, and 922, a plurality of virtual collimator elements 924, 926, and 928, and a plurality of virtual detectors 930, 932, 934, 936, and 938, such as virtual transmission detectors. Processor 190 generates virtual x-ray sources 906, 908, 910, 912, 914, 916, 918, and 920 as a virtual representation of x-ray sources 60, 62, 64, 66, 68, 70, 72, and 74 (FIG. 1) and locates virtual x-ray sources 902, 904, 906, 908, 910, 912, 914, 916, 918, 920, and 922 along a curve 940. Processor 190 generates each of remaining virtual x-ray sources 902, 904, and 922 (FIG. 1) as a virtual representation of an x-ray source, such as x-ray source 74. Moreover, processor 190 generates virtual detector 934 as a virtual representation of transmission detector 17 (FIG. 1). Processor 190 generates each of remaining virtual detectors 930, 932, 936, and 938 as a virtual representation of a transmission detector, such as transmission detector 17. Processor 190 generates a virtual opening 942 as a virtual representation of opening 65 (FIG. 1).

The user provides an organization of the components of system 10 (FIG. 1) to processor 190 via input device 192 (FIG. 2). The user inputs, via input device 192, a plurality of distances between the components of system 10 to processor 190 by providing the distances to processor 190 via input device 192. For example, the user specifies a number of detector elements within transmission detector 17, a number of detector elements within each of scatter detectors 16 and 18, a radius of arc 75, a plurality of positions of x-ray sources 60, 62, 64, 66, 68, 70, 72, and 74 with respect to at least one of transmission detector 17, scatter detector 16, and scatter detector 18, a distance between any two of x-ray sources 60, 62, 64, 66, 68, 70, 72, and 74, and a position of opening 65 with respect to at least one of transmission detector 17, scatter detector 16, and scatter detector 18, and x-ray source 66.

Processor 190 organizes the virtual elements of virtual system 900 and the organization is proportional, by a first

factor, such as one-half or one-third, to the organization of the components of system 10 input by the user. For example, processor 190 generates any two of adjacent virtual x-ray sources from virtual x-ray sources 902, 904, 906, 908, 910, 912, 914, 916, 918, 920, and 922 and a distance between the two adjacent virtual x-ray sources is proportional, such as one-half or one-third, to a distance between any two adjacent x-ray sources from x-ray sources 60, 62, 64, 66, 68, 70, 72, and 74. As another example, processor 190 generates two adjacent virtual detectors from virtual detectors 930, 932, 934, 936, and 938 and a distance between the two adjacent virtual detectors is proportional to a distance between transmission detector 17 (FIG. 1) and another transmission detector (not shown) adjacent to transmission detector 17 (FIG. 1). As yet another example, processor 190 generates virtual x-ray source 912 and virtual detector 934, and a distance between virtual x-ray source 912 and virtual detector 934 is proportional to a distance between x-ray source 66 and transmission detector 17. As still another example, processor 190 generates virtual opening 942 and a distance between virtual opening 942 and virtual x-ray source 912 is proportional to a distance between x-ray source 66 and opening 65. As a further example, processor 190 generates virtual detector 934 and a distance between virtual detector 934 and virtual opening 942 is proportional to a distance between transmission detector 17 and opening 65.

Processor 190 extends a number, such as four or five, of virtual beams, which are straight lines, from each virtual x-ray source 902, 904, 906, 908, 910, 912, 914, 916, 918, 920, and 922. Processor 190 extends the number of virtual beams and the number matches a number of virtual detectors 930, 932, 934, 936, and 938. For example, processor 190 extends five virtual beams from each virtual x-ray source 902, 904, 906, 908, 910, 912, 914, 916, 918, 920, and 922 and upon organizing five virtual detectors 930, 932, 934, 936, and 938 within virtual system 900. As another example, processor 190 extends four virtual beams from each virtual x-ray source 902, 904, 906, 908, 910, 912, 914, 916, 918, 920, and 922 and upon organizing four virtual detectors within virtual system 900.

Processor 190 extends the number of virtual beams from each virtual x-ray source 902, 904, 906, 908, 910, 912, 914, 916, 918, 920, and 922 and each virtual detector 930, 932, 934, 936, and 938 receives one of the virtual beams. For example, processor 190 extends a virtual beam 944, as a straight line, from virtual x-ray source 902 and virtual detector 930 receives virtual beam 944. As another example, processor 190 extends a virtual beam 946, as a straight line, from virtual x-ray source 902 and virtual detector 932 receives virtual beam 946. As yet another example, processor 190 extends a virtual beam 948, as a straight line, from virtual x-ray source 902 and virtual detector 934 receives virtual beam 948. As still another example, processor 190 extends a virtual beam 950, as a straight line, from virtual x-ray source 920 and processor 190 and virtual detector 938 receives virtual beam 950. As another example, processor 190 extends a virtual beam 952, as a straight line, from virtual x-ray source 920 and virtual detector 936 receives virtual beam 952. As yet another example, processor 190 extends a virtual beam 954, as a straight line, from virtual x-ray source 920 and virtual detector 934 receives virtual beam 954.

Processor 190 determines a number of virtual points between virtual x-ray sources 902, 904, 906, 908, 910, 912, 914, 916, 918, 920, and 922 and virtual detectors 930, 932, 934, 936, and 938 and a maximum number, such as 5 or 6, of virtual beams intersect each other at each of the virtual points. As an example, processor 190 determines that five virtual

beams from virtual x-ray sources 904, 906, 908, 910, and 912 intersect each other at a virtual point 956. As another example, processor 190 determines that five virtual beams from virtual x-ray sources 906, 908, 910, 912, and 914 intersect each other at a virtual point 958. The maximum number is equal to the number of virtual beams output by each virtual x-ray source 902, 904, 906, 908, 910, 912, 914, 916, 918, 920, and 922. Similarly, processor 190 determines virtual points 960 and 962. Processor 190 generates an axis 955 that extends through virtual points 956, 958, 960, and 962. Processor 190 generates virtual collimator element 928 that coincides with axis 955 at a plurality of virtual points, such as virtual points 956, 958, 960, and 962. In an alternative embodiment, processor 190 generates a lower or alternatively a higher number of virtual points on axis 955 than a number of virtual points 956, 958, 960, and 962.

Processor 190 determines a number of virtual points between virtual x-ray sources 902, 904, 906, 908, 910, 912, 914, 916, 918, 920, and 922 and virtual detectors 930, 932, 934, 936, and 938 and a number, such as three, lower than the maximum number, of virtual beams intersect each other at each of the virtual points. As an example, processor 190 determines that three virtual beams from virtual x-ray sources 906, 908, and 910 intersect each other at a virtual point 964. As another example, processor 190 determines that three virtual beams from virtual x-ray sources 908, 910, and 912 intersect each other at a virtual point 966. Similarly, processor 190 determines virtual points 968, 970, and 972. Processor 190 generates an axis 963 that extends through virtual points 964, 966, 968, 970, and 972. Processor 190 generates virtual collimator element 926 that coincides with axis 963 at a plurality of virtual points, such as virtual points 964, 966, 968, 970, and 972. As yet another example, processor 190 determines that two virtual beams from virtual x-ray sources 904 and 906 intersect each other at a virtual point 974. As another example, processor 190 determines that two virtual beams from virtual x-ray sources 906 and 908 intersect each other at a virtual point 976. Similarly, processor 190 determines virtual points 978 and 980. Processor 190 generates an axis 982 that extends through virtual points 974, 976, 978, and 980. Processor 190 collates the intersection points to find those which pass through approximately the same x-position. Processor 190 generates virtual collimator element 924 that coincides with axis 982 at a plurality of virtual points, such as virtual points 974, 976, 978, and 980. Virtual collimator element 928 is closest to virtual opening 942 than the remaining virtual collimator elements 924 and 926. In an alternative embodiment, processor 190 generates a lower or alternatively a higher number of virtual points on axis 963 than a number of virtual points 964, 966, 968, 970, and 972. In another alternative embodiment, 190 generates a lower or alternatively a higher number of virtual points on axis 982 than a number of virtual points 974, 976, 978, and 980.

Processor 190 generates virtual collimator elements 924, 926, and 928 and virtual collimator elements 924, 926, and 928 do not intersect virtual opening 942. In an alternative embodiment, virtual collimator elements 924, 926, and 928 do not intersect container 79. Processor 190 generates virtual collimator elements 924, 926, and 928 that lie between virtual x-ray sources 902, 904, 906, 908, 910, 912, 914, 916, 918, 920, and 922 and virtual opening 942. Processor 190 determines a plurality of virtual positions, such as x_{v1} and y_{v1} virtual co-ordinates or x_{v2} and y_{v2} virtual co-ordinates or x_{v3} and y_{v3} virtual co-ordinates, of virtual collimator elements 924, 926, and 928 and determines a plurality of positions, such as x_{v4} and y_{v4} virtual co-ordinates, x_{v5} and y_{v5} virtual co-ordinates, x_{v6} and y_{v6} virtual co-ordinates, x_{v7} and y_{v7}

virtual co-ordinates, $x_{v,8}$ and $y_{v,8}$ virtual co-ordinates, or $x_{v,9}$ and $y_{v,9}$ virtual co-ordinates, of virtual points on virtual collimator elements **924**, **926**, and **928**. For example, processor **190** determines the $x_{v,1}$ and $y_{v,1}$ virtual co-ordinates of virtual collimator element **928** with respect to an origin of an x_v, y_v, z_v co-ordinate system. As another example, processor **190** determines the $x_{v,4}$ and $y_{v,4}$ virtual co-ordinates of virtual point **974** with respect to the origin of the x_v, y_v, z_v co-ordinate system. The x_v, y_v, z_v co-ordinate system is proportional to the xyz co-ordinate system shown in FIGS. **1**, **4**, and **5**. The x_v, y_v, z_v co-ordinate system includes an x_v axis, a y_v axis, and a z_v axis. The x_v axis is perpendicular to the y_v axis and the z_v axis, and the y_v axis is perpendicular to the z_v axis.

It is noted that virtual collimator elements **924**, **926**, and **928** are curved and that none of virtual collimator elements **924**, **926**, and **928** are circular in shape. It is also noted that in an alternative embodiment, processor **190** generates virtual collimator element **928** and does not generate any other virtual collimator element. In yet another alternative embodiment, processor **190** generates any number, such as 2, 3, 4, or 5, of virtual collimator elements.

FIG. **7** is a diagram of an embodiment of a system **1000** implementing a primary collimator. System **1000** is an example of system **10** (FIG. **1**) and system **600** (FIG. **4**). Alternatively, system **1000** is an example of system **700** (FIG. **5**). System **1000** includes gantry **12**. Gantry **12** includes opening **65**, x-ray sources **60**, **62**, **64**, **66**, **68**, **70**, **72**, and **74**, a plurality of primary collimator elements **1002**, **1004**, and **1006**, and a plurality of holders **1008**, **1010**, **1012**, **1014**, **1016**, and **1018**. An example of each of primary collimator elements **1002**, **1004**, and **1006** include a sheet or a lamination. Primary collimator elements **1002**, **1004**, and **1006** are fabricated from a material, such as molybdenum or tungsten. Holders **1008**, **1010**, **1012**, **1014**, **1016**, and **1018** are fabricated from a metal, such as steel or aluminum. Primary collimator elements **1002**, **1004**, and **1006** are located between x-ray sources **60**, **62**, **64**, **66**, **68**, **70**, **72**, and **74** and opening **65**, and collectively form primary collimator **14** (FIG. **1**). As an example, each primary collimator element **1002**, **1004**, and **1006** has a length ranging from and including 1 meters (m) to 1.5 meters in the y-direction, ranging from and including 0.5 millimeters (mm) to 5 mm in the z-direction, and ranging from and including 2.5 mm to 5.5 mm in the x-direction.

Primary collimator element **1002** is supported by holders **1008** and **1014**. Primary collimator element **1004** is supported by holders **1010** and **1016**, and primary collimator element **1006** is supported by holders **1012** and **1018**. Holders **1008**, **1010**, **1012**, **1014**, **1016**, and **1018** are attached by a connection process, such as gluing or spot welding, to a plurality of side walls **1020** and **1022** of gantry **12**. For example, holders **1008**, **1010**, and **1012** are attached to side wall **1020** and holders **1014**, **1016**, and **1018** are attached to side wall **1022**. Alternatively, holders **1008**, **1010**, **1012**, **1014**, **1016**, and **1018** are attached to side walls **1020** and **1022** by fitting holders **1008**, **1010**, and **1012** to side wall **1020** via a plurality of screws and by fitting holders **1014**, **1016**, and **1018** to side wall **1022** via a plurality of screws. Each of holders **1008**, **1010**, **1012**, **1014**, **1016**, and **1018** include a slot that extends in the z-direction. For example, holder **1008** includes a slot **1024**, holder **1010** includes a slot **1026**, holder **1012** includes a slot **1028**, holder **1014** includes a slot **1030**, holder **1016** includes a slot **1032**, and holder **1018** includes a slot **1034**.

The user fabricates holders **1008**, **1010**, **1012**, **1014**, **1016**, and **1018** and slots **1024**, **1026**, **1028**, **1030**, **1032**, and **1034** by using a molding machine having a plurality of peaks of a shape of any of slots **1024**, **1026**, **1028**, **1030**, **1032**, and **1034**, filling a liquid metal, such as steel, within the molding

machine, and cooling the metal to create slots **1024**, **1026**, **1028**, **1030**, **1032**, and **1034** within holders **1008**, **1010**, **1012**, **1014**, **1016**, and **1018**. Alternatively, the user creates slots **1024**, **1026**, **1028**, **1030**, **1032**, and **1034** by operating an etching machine to develop slots **1024**, **1026**, **1028**, **1030**, **1032**, and **1034**. Each of slots **1024**, **1026**, **1028**, **1030**, **1032**, and **1034** have a plurality of dimensions that are slightly larger than a plurality of dimensions of each of primary collimator elements **1002**, **1004**, and **1006**. For example, if primary collimator element **1002** has a dimension along the x-axis of 5 mm, slot **1024** has a dimension along the x-axis of more than 5 mm, such as 5.2 mm. As another example, if primary collimator element **1002** has a dimension along the y-axis of 1.2 m, slot **1024** has a dimension along the y-axis of more than 1.2 m, such as 1.5 m. As yet another example, if primary collimator element **1002** has a dimension along the z-axis of 1 mm, slot **1024** has a dimension along the y-axis of more than 1.2 mm, such as 1.5 mm.

The user slides a primary collimator element within slots to use holders to support primary collimator element. For example, the user slides, in the z-direction, primary collimator element **1002** within slot **1024** of holder **1008** and slot **1030** of holder **1014** to use holders **1008** and **1014** to support primary collimator element **1002**. As another example, the user slides, in the z-direction, primary collimator element **1004** within slot **1026** of holder **1010** and slot **1032** of holder **1016** to use holders **1010** and **1016** to support primary collimator element **1004**.

Processor **190** calculates a plurality of positions, such as x_1 and y_1 co-ordinates, x_2 and y_2 co-ordinates, or x_3 and y_3 co-ordinates, of primary collimator elements **1002**, **1004**, and **1006** within gantry **12** as being proportional, by a second factor, such as 2 or 3, to the virtual positions of virtual collimator elements **924**, **926**, and **928**. For example, processor **190** multiplies the co-ordinates $x_{v,1}$ and $y_{v,1}$ co-ordinates of virtual collimator element **928** with the second factor to generate the x_1 and y_1 co-ordinates of primary collimator element **1006**. As another example, processor **190** multiplies the $x_{v,2}$ and $y_{v,2}$ co-ordinates of virtual collimator element **926** with the second factor to generate the x_2 and y_2 co-ordinates of primary collimator element **1004**. As yet another example, processor **190** multiplies the $x_{v,3}$ and $y_{v,3}$ co-ordinates of virtual collimator element **924** with the second factor to generate the co-ordinates x_3 and y_3 of primary collimator element **1002**. The second factor is an inverse of the first factor. For example, if the first factor is one-half, the second factor is 2.

Virtual collimator element **924** (FIG. **6**) is a virtual representation of primary collimator element **1002**, virtual collimator element **926** (FIG. **6**) is a virtual representation of primary collimator element **1004**, and virtual collimator element **928** (FIG. **6**) is a virtual representation of primary collimator element **1006**. Primary collimator **14** includes any number, such as 2, 3, or 4, of primary collimator elements, such as primary collimator elements **1002**, **1004**, and **1006**. Primary collimator element **1006** has a minimum number of apertures compared to a number of apertures in either primary collimator element **1002** or primary collimator element **1004**. It is advantageous to have primary collimator element **1006** with the minimum number of apertures. The minimum number of apertures depends on a size of container **79** and a number of x-ray sources for scanning container **79**.

FIG. **8** is a top view of an embodiment of gantry **12**. Gantry **12** includes primary collimator element **1002** and holders **1008** and **1014**. Primary collimator element **1002** includes a plurality of apertures **1040**, **1042**, **1044**, **1046**, **1048**, **1050**, **1052**, and **1054**. A number of apertures within primary collimator element **1002** is equal to a number of virtual points on

virtual collimator element **924**. Processor **190** outputs a plurality of positions, such as the co-ordinates x_4 and y_4 , of apertures within primary collimator element **1002** as being proportional by the second factor to the positions of virtual points of virtual collimator element **924**. For example, processor **190** multiplies the virtual co-ordinates $x_{v,4}$ and $y_{v,4}$ of virtual point **974** with the second factor to generate the co-ordinates x_4 and y_4 of aperture **1042** of primary collimator element **1002**. As another example, processor **190** multiplies the co-ordinates $x_{v,5}$ and $y_{v,5}$ of virtual point **976** with the second factor to generate a plurality of co-ordinates x_5 and y_5 of aperture **1044** of primary collimator element **1002**.

Slot **1024** has a length in the z-direction greater than a length of primary collimator element **1002** in the z-direction. For example, slot **1024** extends, within holder **1008**, from a point **1056** to a point **1058**, along the z-direction and primary collimator element **1002** extends from a point **1060** to point **1058**, along the z-direction. A distance, in the z-direction, between points **1058** and **1060** is less than a distance, in the z-direction, between points **1056** and **1058**. The user slides, in the z-direction, primary collimator element **1002** from a side **1062** of holder **1008** into slot **1024** and from a side **1064** of holder **1014** into slot **1030** to locate primary collimator element **1002** within slots **1024** and **1030**.

FIG. **9** is a top view of an embodiment of gantry **12**. Gantry **12** includes primary collimator element **1004** and holders **1010** and **1016**. Primary collimator element **1004** includes a plurality of apertures **1070**, **1072**, **1074**, **1076**, **1078**, **1080**, **1082**, and **1084**. A number of apertures within primary collimator element **1004** is equal to a number of virtual points on virtual collimator element **926**. Processor **190** outputs a plurality of positions, such as the co-ordinates x_6 and y_6 , of apertures **1070**, **1072**, **1074**, **1076**, **1078**, **1080**, **1082**, and **1084** within primary collimator element **1004** as being proportional by the second factor to the virtual positions of virtual points of virtual collimator element **926** (FIG. **6**). For example, processor **190** multiplies the virtual co-ordinates $x_{v,6}$ and $y_{v,6}$ of virtual point **964** (FIG. **6**) with the second factor to generate the co-ordinates x_6 and y_6 of aperture **1074** of primary collimator element **1004**. As another example, processor **190** multiplies the co-ordinates $x_{v,7}$ and $y_{v,7}$ of virtual point **966** (FIG. **6**) with the second factor to generate a plurality of co-ordinates x_7 and y_7 of aperture **1076** of primary collimator element **1004**.

Slot **1026** has a length in the z-direction greater than a length of primary collimator element **1004** in the z-direction. For example, slot **1026** extends, within holder **1010**, from a point **1086** to a point **1088**, along the z-direction and primary collimator element **1004** extends from a point **1090** to point **1088**, along the z-direction. A distance, in the z-direction, between points **1088** and **1090** is less than a distance, in the z-direction, between points **1086** and **1088**. The user slides, in the z-direction, primary collimator element **1004** from a side **1092** of holder **1010** into slot **1026** and from a side **1094** of holder **1016** into slot **1032** to locate primary collimator element **1004** within slots **1026** and **1032**.

FIG. **10** is a top view of an embodiment of gantry **12**. Gantry **12** includes primary collimator element **1006** and holders **1012** and **1018**. Primary collimator element **1006** includes a plurality of apertures **1200**, **1202**, **1204**, **1206**, **1208**, **1210**, **1212**, and **1214**. A number of apertures within primary collimator element **1006** is equal to a number of virtual points on virtual collimator element **928**. Processor **190** outputs a plurality of positions, such as the co-ordinates x_8 and y_8 , of apertures **1200**, **1202**, **1204**, **1206**, **1208**, **1210**, **1212**, and **1214** within primary collimator element **1006** as being proportional by the second factor to the virtual posi-

tions of virtual points of virtual collimator element **928**. For example, processor **190** multiplies the virtual co-ordinates $x_{v,8}$ and $y_{v,8}$ of virtual point **956** with the second factor to generate the co-ordinates x_8 and y_8 of aperture **1202** of primary collimator element **1006**. As another example, processor **190** multiplies the co-ordinates $x_{v,9}$ and $y_{v,9}$ of virtual point **958** with the second factor to generate a plurality of co-ordinates x_9 and y_9 of aperture **1204** of primary collimator element **1006**.

Slot **1028** has a length in the z-direction greater than a length of primary collimator element **1006** in the z-direction. For example, slot **1028** extends, within holder **1012**, from a point **1216** to a point **1218**, along the z-direction and primary collimator element **1006** extends from a point **1220** to point **1218**, along the z-direction. A distance, in the z-direction, between points **1218** and **1220** is less than a distance, in the z-direction, between points **1216** and **1218**. The user slides, in the z-direction, primary collimator element **1006** from a side **1222** of holder **1012** into slot **1028** and a side **1224** of holder **1018** into slot **1034** to locate primary collimator element **1006** within slots **1028** and **1034**.

The user creates apertures **1040**, **1042**, **1044**, **1046**, **1048**, **1050**, **1052**, **1054**, **1070**, **1072**, **1074**, **1076**, **1078**, **1080**, **1082**, **1084**, **1200**, **1202**, **1204**, **1206**, **1208**, **1210**, **1212**, and **1214** (FIGS. **8-10**) by applying a process, such as a molding process. For example, the user creates apertures **1040**, **1042**, **1044**, **1046**, **1048**, **1050**, **1052**, and **1054** of primary collimator element **1002** by using a molding machine having a plurality of peaks of a shape of any of apertures **1040**, **1042**, **1044**, **1046**, **1048**, **1050**, **1052**, and **1054**, filling a metal, such as tungsten or molybdenum, within the molding machine, and cooling the metal to create apertures **1040**, **1042**, **1044**, **1046**, **1048**, **1050**, **1052**, and **1054**. As an example, each aperture **1040**, **1042**, **1044**, **1046**, **1048**, **1050**, **1052**, **1054**, **1070**, **1072**, **1074**, **1076**, **1078**, **1080**, **1082**, **1084**, **1200**, **1202**, **1204**, **1206**, **1208**, **1210**, **1212**, and **1214** (FIGS. **8-10**) has a width ranging from and including 0.5 mm to 1.5 mm in the y-direction, a depth ranging from and including 0.1 mm to 0.5 mm in the z-direction, and a thickness ranging from and including 2.5 mm to 5.5 mm in the x-direction. A thickness of each aperture in the x-direction is the same as a thickness, in the x-direction, of a primary collimator element that includes the aperture. For example, a thickness of aperture **1040** in the x-direction is the same as a thickness of primary collimator element **1002** in the x-direction. The user creates apertures **1040**, **1042**, **1044**, **1046**, **1048**, **1050**, **1052**, **1054**, **1070**, **1072**, **1074**, **1076**, **1078**, **1080**, **1082**, **1084**, **1200**, **1202**, **1204**, **1206**, **1208**, **1210**, **1212**, and **1214** as having the same location, along the z-axis, as that of x-ray sources **60**, **62**, **64**, **66**, **68**, **70**, **72**, and **74** (FIG. **1**) along the z-axis.

When x-ray beam **67** (FIG. **1**) passes through primary collimator **14**, primary collimator **14** collimates x-ray beam **67** to generate primary beams **83** and **84** (FIG. **1**) from two apertures **1046** and **1048** (FIG. **8**), respectively. Alternatively or in addition, when x-ray beam **67** (FIG. **1**) passes through primary collimator **14**, primary collimator **14** collimates x-ray beam **67** to generate primary beams **83** and **84** (FIG. **1**) from two apertures **1076** and **1078** (FIG. **9**), respectively. Moreover, alternatively or in addition, when x-ray beam **67** (FIG. **1**) passes through primary collimator **14**, primary collimator **14** collimates x-ray beam **67** to generate primary beams **83** and **84** (FIG. **1**) from two apertures **1206** and **1208**, respectively. Each aperture outputs a primary beam. For example, aperture **1072** (FIG. **9**) outputs a primary beam. As another example, aperture **1200** outputs a primary beam.

It is noted that an additional primary collimator element (not shown) is included within primary collimator **14** and

coincides with points corresponding to a plurality of virtual points other than virtual points at which at least two beams from virtual x-ray sources **902**, **904**, **906**, **908**, **910**, **912**, **914**, **916**, **918**, **920**, and **922** intersect. The additional primary collimator element is parallel to any one of primary collimator elements **1002**, **1004**, and **1006** and includes a plurality of apertures to allow x-rays from x-ray sources **60**, **62**, **64**, **66**, **68**, **70**, **72**, and **74** to reach any of primary collimator elements **1002**, **1004**, and **1006**. In an alternative embodiment, primary collimator **14** does not include the additional primary collimator element.

FIG. **11** is a diagram of an alternative embodiment of a gantry **1302**. Gantry **1302** is an example of gantries **602** (FIG. **4**) and **702** (FIG. **5**). Gantry **1302** includes opening **65**, a plurality of holders **1304**, **1306**, **1308**, **1310**, **1312**, and **1314**, and primary collimator elements **1002**, **1004**, and **1006**. The user fabricates holders **1304**, **1306**, **1308**, **1310**, **1312**, and **1314** from a metal, such as steel or aluminum. For example, the user fabricates holders **1304**, **1306**, **1308**, **1310**, **1312**, and **1314** by using a molding machine including molds of a shape of any of holders **1304**, **1306**, **1308**, **1310**, **1312**, and **1314**, filling the molding machine with a liquid metal, such as steel, and cooling the liquid metal. The user attaches a primary collimator element to a plurality of top surfaces of holders by a process, such as spot welding or gluing, or alternatively by using screws. For example, the user attaches primary collimator element **1002** with holder **1304** by gluing a bottom surface **1316** of primary collimator element **1002** to a top surface **1318** of holder **1304** and gluing bottom surface **1316** of primary collimator element **1002** to a top surface **1320** of holder **1310**. As another example, the user attaches primary collimator element **1004** with holder **1306** by spot welding a bottom surface **1322** of primary collimator element **1004** with a top surface **1324** of holder **1306** and spot welding bottom surface of primary collimator element **1004** with a top surface **1326** of holder **1312**. Holders **1304**, **1306**, **1308**, **1310**, **1312**, and **1314** do not include slots. Alternatively, the user attaches a top surface of a primary collimator element with a plurality of bottom surfaces of holders. For example, the user attaches a top surface **1328** of primary collimator element **1006** with a bottom surface **1330** of holder **1308** and a bottom surface **1332** of holder **1314**.

FIG. **12** is a top view of an embodiment of gantry **1302**. Gantry **1302** includes a plurality of holders **1402** and **1404**, and a primary collimator element **1406**. Primary collimator element **1406** is an example of any of primary collimator elements **1002**, **1004**, and **1006** (FIG. **11**). Holders **1402** and **1404** are examples of holders **1304** and **1310** (FIG. **11**), respectively, if primary collimator element **1406** is an example of primary collimator element **1002**. Holders **1402** and **1404** are examples of holders **1306** and **1312** (FIG. **11**), respectively, if primary collimator element **1406** is an example of primary collimator element **1004**. Holders **1402** and **1404** are examples of holders **1308** and **1314** (FIG. **11**), respectively, if primary collimator element **1406** is an example of primary collimator element **1006**. Primary collimator element **1406** is attached to a top surface **1408** of holder and to a top surface **1410** of holder.

Technical effects of the herein described systems and methods for generating an improved diffraction profile include increasing a single-to-noise ratio detected by providing at least two scatter detectors, such as scatter detectors **16** and **18**, to detect scattered radiation. Other technical effects include examining by at least two scatter detectors, such as scatter detectors **16** and **18**, of container **79** that is larger than a container (not shown) examined by a single scatter detector. Yet other technical effect includes an improved coverage of

container **79** with primary x-rays. Still other technical effects include providing an improved diffraction profile by measuring energy at points **94** and **95**. Yet other technical effects include a reduction in power consumed by x-ray sources **60**, **62**, **64**, **66**, **68**, **70**, **72**, and **74**. The reduction in power is achieved by using a plurality of scatter detectors, such as scatter detectors **16** and **18**, to detect scattered radiation. The power consumed by x-ray sources **60**, **62**, **64**, **66**, **68**, **70**, **72**, and **74** to generate a diffraction profile having a certain quality is reduced compared to a power consumed by a plurality of x-ray sources to provide x-rays to a single scatter detector that is used to generate the diffraction profile of the same quality. For example, a plurality of x-ray sources consume a high amount, such as 90 kilowatts (kW), of power to acquire a number of scattered x-ray photons detected by a single scatter detector in a restricted scan time to generate a diffraction profile of the scattered x-ray photons. The high amount of power is higher than a low amount, such as at most half of the high amount, of power consumed by x-ray sources **60**, **62**, **64**, **66**, **68**, **70**, **72**, and **74** to acquire the number of scattered x-ray photons detected by at least two scatter detectors, such as scatter detectors **16** and **18**, in the restricted scan time.

The scatter angle **98** is larger than, such as at least twice compared to, scatter angle **96**. Energy of scattered x-ray photons scattered from point **85** onto scatter detector **18** is at least twice that of energy of scattered x-ray photons scattered from point **85** onto detector **16** at the same momentum transfer x_A . As a result, most of scattered x-ray photons from point **85** onto scatter detector **16** are absorbed by container **79**. Moreover, energy of scattered x-ray photons scattered from point **85** onto scatter detector **18** is at least twice that of energy of scattered x-ray photons scattered from point **86** onto scatter detector **18** at the same momentum transfer x_A . As a result, most of scattered x-ray photons from point **86** onto scatter detector **18** are absorbed by container **79**. Furthermore, energy of scattered x-ray photons scattered from point **85** onto scatter detector **708** is at least twice that of energy of scattered x-ray photons scattered from point **85** onto detector **710** at the same momentum transfer x_B . As a result, most of scattered x-ray photons from point **85** onto scatter detector **710** are absorbed by container **79**. Moreover, energy of scattered x-ray photons scattered from point **85** onto scatter detector **708** is at least twice that of energy of scattered x-ray photons scattered from point **86** onto detector **708** at the same momentum transfer x_B . As a result, most of scattered x-ray photons from point **86** onto scatter detector **708** are absorbed by container **79**. Energies, such as ranging from and including 30 kiloelectron volts (keV) to 200 keV, of scattered x-ray photons at scatter angle **98** detected by scatter detector **16** is lower than energies of scattered x-ray photons at scatter angle **96** detected by scatter detector **18**. As a result, most of scattered x-ray photons within scattered radiation **89** are attenuated by container **79**.

Moreover, scattered x-ray photons within scattered radiation **89** can be absorbed by a filter, such as a metal or a copper filter, placed between support **80** and secondary collimator **76**. Absorption of scattered x-ray photons within scattered radiation **89** by container **79** and/or the filter prevents an overload and a dead time of scatter detector **16**. Moreover, absorption of scattered x-ray photons within scattered radiation **89** by container **79** and/or the filter prevents an interference of the scattered x-ray photons with scattered radiation **88**.

While the invention has been described in terms of various specific embodiments, those skilled in the art will recognize that the invention can be practiced with modification within the spirit and scope of the claims.

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What is claimed is:

1. A system for generating a diffraction profile of an object, said system comprising:

at least one x-ray source configured to generate x-rays;
a primary collimator configured to divide the generated x-rays into a first x-ray beam directed to a first focus point within an object space and a second x-ray beam directed to a second focus point within the object space; and

a first scatter detector configured to:

detect a first set of scattered radiation generated upon intersection of the first x-ray beam with the object at a first point on said first scatter detector; and

detect a second set of scattered radiation generated upon intersection of the second x-ray beam with the object at the first point on said first scatter detector.

2. A system in accordance with claim 1, further comprising a second scatter detector separated by a gap from said first scatter detector, said second scatter detector configured to:

detect a third set of scattered radiation generated upon intersection of the first x-ray beam with the object; and

detect a fourth set of scattered radiation generated upon intersection of the second x-ray beam with the object, the third set of scattered radiation and the fourth set of scattered radiation detected at a second point on said second scatter detector.

3. A system in accordance with claim 2, wherein an angle of scatter of the first set of scattered radiation detected by said first scatter detector is equal to an angle of scatter of the third set of scattered radiation detected by said second scatter detector.

4. A system in accordance with claim 1, wherein an angle of scatter of the first set of scattered radiation detected by said first scatter detector is at most one-half of an angle of scatter of the second set of scattered radiation detected by said first scatter detector.

5. A system in accordance with claim 2, further comprising:

a third scatter detector configured to detect a fifth set of scattered radiation generated upon intersection of the first x-ray beam with the object; and

a fourth scatter detector configured to detect a sixth set of scattered radiation generated upon intersection of the second x-ray beam with the object.

6. A system in accordance with claim 1, further comprising a transmission detector configured to detect the first x-ray beam and the second x-ray beam.

7. A system in accordance with claim 5, further comprising:

a transmission detector configured to detect the first x-ray beam and the second x-ray beam; and

a gantry, wherein said transmission detector, said first scatter detector, said second scatter detector, said third scatter detector, and said fourth scatter detector are located within said gantry.

8. A system for generating a diffraction profile of an object, said system comprising:

at least one x-ray source configured to generate x-rays;

a primary collimator configured to divide the generated x-rays into a first x-ray beam directed to a first focus point within an object space and a second x-ray beam directed to a second focus point within the object space;

a first scatter detector configured to:

detect a first set of scattered radiation generated upon intersection of the first x-ray beam with the object at a first point on said first scatter detector; and

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detect a second set of scattered radiation generated upon intersection of the second x-ray beam with the object at the first point on said first scatter detector; and

a processor coupled to said first scatter detector and configured to generate a portion of a diffraction profile of the object from the first set of scattered radiation and the second set of scattered radiation detected by said first scatter detector.

9. A system in accordance with claim 8, further comprising a second scatter detector separated by a gap from said first scatter detector, said second scatter detector configured to:

detect a third set of scattered radiation generated upon intersection of the first x-ray beam with the object; and

detect a fourth set of scattered radiation generated upon intersection of the second x-ray beam with the object, the third set of scattered radiation and the fourth set of scattered radiation detected at a second point on said second scatter detector.

10. A system in accordance with claim 9, wherein an angle of scatter of the first set of scattered radiation detected by said first scatter detector is equal to an angle of scatter of the third set of scattered radiation detected by said second scatter detector.

11. A system in accordance with claim 9, further comprising:

a third scatter detector configured to detect a fifth set of scattered radiation generated upon intersection of the first x-ray beam with the object; and

a fourth scatter detector configured to detect a sixth set of scattered radiation generated upon intersection of the second x-ray beam with the object.

12. A system in accordance with claim 11, further comprising a transmission detector configured to detect the first x-ray beam and the second x-ray beam, wherein said first and second scatter detectors are placed on a first side of said transmission detector, the first side is opposite to a second side of said transmission detector, and said third and fourth scatter detectors are placed on the second side.

13. A system in accordance with claim 9, further comprising:

a transmission detector configured to detect the first x-ray beam and the second x-ray beam; and

a gantry, wherein said transmission detector, said first scatter detector, and said second scatter detector are located within said gantry.

14. A system in accordance with claim 8, wherein an angle of scatter of the first set of scattered radiation detected by said first scatter detector is at most one-half of an angle of scatter of the second set of scattered radiation detected by said first scatter detector.

15. A method for generating a diffraction profile of an object, said method comprising:

generating x-rays by activating at least one x-ray source; dividing the generated x-rays, using a primary collimator, into a first x-ray beam directed to a first focus point within an object space and a second x-ray beam directed to a second focus point within the object space;

detecting a first set of scattered radiation generated upon intersection of the first x-ray beam with the object at a first point on a first scatter detector; and

detecting a second set of scattered radiation generated upon intersection of the second x-ray beam with the object at the first point on the first scatter detector.

16. A method in accordance with claim 15, further comprising:

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collimating the first set of scattered radiation for detection by the first scatter detector, the first set of scattered radiation collimated to impinge on the first scatter detector at the first point; and

collimating the second set of scattered radiation for detection by the first scatter detector, the second set of scattered radiation collimated to impinge on the first scatter detector at the first point.

17. A method in accordance with claim 15, further comprising:

detecting, by a second scatter detector, a third set of scattered radiation generated upon intersection of the first x-ray beam with the object;

detecting, by the second scatter detector, a fourth set of scattered radiation generated upon intersection of the second x-ray beam with the object, the third set of scattered radiation and the fourth set of scattered radiation detected at a second point on the second scatter detector;

collimating the third set of scattered radiation for detection by the second scatter detector, the third set of scattered radiation collimated to impinge on the second scatter detector at the second point; and

collimating the fourth set of scattered radiation for detection by the second scatter detector, the fourth set of scattered radiation collimated to impinge on the second scatter detector at the second point.

18. A method in accordance with claim 17, further comprising:

detecting, by a transmission detector, the first x-ray beam and the second x-ray beam;

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detecting, by a third scatter detector, a fifth set of scattered radiation generated upon intersection of the first x-ray beam with the object; and

detecting, by a fourth scatter detector, a sixth set of scattered radiation generated upon intersection of the second x-ray beam with the object, wherein the first and second scatter detectors are placed on a first side of the transmission detector, the first side is opposite to a second side of the transmission detector, and the third and fourth scatter detectors are placed on the second side.

19. A method in accordance with claim 17, further comprising:

detecting, by a third scatter detector, a fifth set of scattered radiation generated upon intersection of the first x-ray beam with the object; and

detecting, by a fourth scatter detector, a sixth set of scattered radiation generated upon intersection of the second x-ray beam with the object.

20. A method in accordance with claim 19, further comprising:

collimating the fifth set of scattered radiation for detection by the third scatter detector, the fifth set of scattered radiation collimated to impinge on the third scatter detector at a third point; and

collimating the sixth set of scattered radiation for detection by the fourth scatter detector, the sixth set of scattered radiation collimated to impinge on the fourth scatter detector at a fourth point.

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